

integration with integrity

User's Manual Single Board Computer 3307675 Version 1.0, April 2007

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Packing List



NOTE:

If any of the components listed in the checklist below are missing, please do not proceed with the installation. Contact the GLOBAL AMERICAN, INC. reseller or vendor you purchased the 3307675 from or contact a Global American sales representative directly. To contact a Global American sales representative, please send an email to salesinfo@globalamericaninc.com.

The items listed below should all be included in the 3307675 package.

- 1 x 3307675 single board computer
- 1 x IDE cable
- 3 x SATA power cables
- 6 x SATA cables
- 1 x Dual RS-232 cable
- 1 x USB cable
- 1 x Mini jumper pack
- 1 x Utility CD
- 1 x 1 x QIG (quick installation guide)

Images of the above items are shown in **Chapter 3**.

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Glossary

AC '97	Audio Codec 97		
ACPI	Advanced Configuration and	HDD	Hard Disk Drive
	Power Interface	IDE	Integrated Data Electronics
APM	Advanced Power Management	I/O	Input/Output
ARMD	ATAPI Removable Media Device	ICH4	I/O Controller Hub 4
ASKIR	Shift Keyed Infrared	L1 Cache	Level 1 Cache
ATA	Advanced Technology	L2 Cache	Level 2 Cache
	Attachments	LCD	Liquid Crystal Display
BIOS	Basic Input/Output System	LPT	Parallel Port Connector
CFII	Compact Flash Type 2	LVDS	Low Voltage Differential Signaling
CMOS	Complementary Metal Oxide	MAC	Media Access Controller
	Semiconductor	os	Operating System
CPU	Central Processing Unit	PCI	Peripheral Connect Interface
Codec	Compressor/Decompressor	PIO	Programmed Input Output
COM	Serial Port	PnP	Plug and Play
DAC	Digital to Analog Converter	POST	Power On Self Test
DDR	Double Data Rate	RAM	Random Access Memory
DIMM	Dual Inline Memory Module	SATA	Serial ATA
DIO	Digital Input/Output	S.M.A.R.T	Self Monitoring Analysis and
DMA	Direct Memory Access		Reporting Technology
EIDE	Enhanced IDE	SPD	Serial Presence Detect
EIST	Enhanced Intel SpeedStep	S/PDI	Sony/Philips Digital Interface
	Technology	SDRAM	Synchronous Dynamic Random
FDD	Floppy Disk Drive		Access Memory
FDC	Floppy Disk Connector	SIR	Serial Infrared
FFIO	Flexible File Input/Output	UART	Universal Asynchronous
FIFO	First In/First Out		Receiver-transmitter
FSB	Front Side Bus	USB	Universal Serial Bus
IrDA	Infrared Data Association	VGA	Video Graphics Adapter

Chapter 1

Introduction

1.1 Overview

The 3307675 PICMG 1.3 form factor CPU card is a LGA775 Intel® Core™2 Quad, Pentium® D, Pentium® 4 or Celeron® D platform. Up to 8GB of DDR2 SDRAM and up to six SATA II hard disk drives (HDD) are supported. High-performance PCI Express (PCIe) Gigabit Ethernet (GbE) connectivity is integrated into the system. Six USB 2.0 connectors (two external and four internal) enable system flexibility and expansion.

1.1.1 3307675 Expansion Options

The 3307675 PICMG 1.3 form factor enables PCIe x16, PCIe x4, PCIe x1 and PCI expansion cards to easily be added to the PICMG 1.3 compatible backplane the 3307675 is installed on. Expansion cards in the combinations shown in **Table 1-1** below can be installed on compatible backplanes.

	PCIe x16	PCIe x4	PCIe x1	PCI
Combination 1	1	1	0	4
Combination 2	1	0	4	4
Combination 3	0	1	1	4
Combination 4	0	0	5	4

Table 1-1: Technical Specifications

1.1.2 3307675 Features

Some of the 3307675 features are listed below.

- Supports LGA775 Intel® CPUs including:
 - O Intel® Core™2 Quad
 - O Intel® Core™2 Duo
 - O Intel® Pentium® D
 - O Intel® Pentium® 4
 - O Intel® Celeron® D
- Maximum FSB of 1066MHz
- Supports four 240-pin 533MHz, 667MHz or 800MHz 2GB DDR2 memory modules

- Six SATA II drives with transfer rates of 3.0Gb/s supported
- Two Ultra ATA 100, Ultra ATA 66 or Ultra ATA 33 IDE HDDs supported
- Six USB 2.0 devices supported
- Dual PCIe GbE Ethernet connectors
- PICMG 1.3 form factor
- RoHS compliant
- Supports ATX power supplies

1.2 3307675 Overview

1.2.1 3307675 Overview Photo

The 3307675 has a wide variety of peripheral interface connectors. **Figure 1-1** is a labeled photo of the peripheral interface connectors on the 3307675.

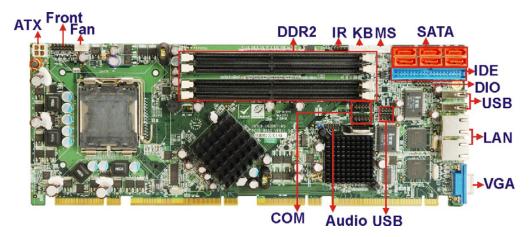


Figure 1-1: 3307675 Overview [Front View]

1.2.2 3307675 Peripheral Connectors and Jumpers

The 3307675 has the following connectors on-board:

- 1 x ATX power connector
- 1 x Audio connector
- 1 x Digital input/output connector
- 1 x Fan connector
- 1 x Front panel connector
- 1 x IDE disk drive connector

- 1 x Infrared interface connector
- 1 x Keyboard connector
- 1 x Mouse connector
- 6 x Serial ATA II (SATA II) drive connectors
- 2 x Serial port connectors
- 2 x USB 2.0 connectors

The 3307675 has the following external peripheral interface connectors on the board rear panel

- 2 x Ethernet connectors
- 2 x USB 2.0 port connectors
- 1 x VGA connector

The 3307675 has the following on-board jumpers:

Clear CMOS

1.2.3 Technical Specifications

3307675 technical specifications are listed in **Table 1-2**. See **Chapter 2** for details.

Specification	3307675
Form Factor	PICMG 1.3
System CPU	LGA775 Intel® Core™ 2 Quad
	LGA775 Intel® Core™ 2 Duo
	LGA775 Intel® Pentium® D
	LGA775 Intel® Pentium® 4
	LGA775 Intel® Celeron® D
Front Side Bus	533MHz, 800MHz or 1066MHz
System Chipset	Northbridge: Intel® Q965
	Southbridge: Intel® ICH8DO

Memory	Four dual channel 240-pin DDR2 DIMM sockets support four 533MHz, 667MHz or 800MHz DIMMs with a maximum capacity each with a maximum capacity of 2GB
Display	VGA integrated into the Intel® Q965
BIOS	AMI Flash BIOS
Audio	7.1 channel HD audio kit with Realteck ALC883 and dual audio streams supported
LAN	Dual Intel® PC82573L PCIe GbE chipset
сом	Two RS-232 serial ports (two internal, one external)
USB2.0	Six USB 2.0 devices supported
IDE	One 40-pin IDE connector connects to two Ultra ATA33/66/100 devices
SATA	Six 3.0Gb/s SATA II drives supported
Keyboard/mouse	One internal keyboard connector One internal mouse connector
Watchdog Timer	Software programmable 1-255 sec. by super I/O
Power Supply	ATX power only
Power Consumption	5V@8.93A, 12V@7.42A and 3.3V@6.42A (Intel® Core™2 Extreme QX6700 2.66GHz, 4GB 800MHz DDR2)

Temperature	0°C – 60°C (32°F - 140°F)
Humidity (operating)	5%~95% non-condensing
Dimensions (LxW)	338mm x 122mm
Weight (GW/NW)	1200g/ 474g

Table 1-2: Technical Specifications

Chapter

2

Detailed Specifications

2.1 Dimensions

2.1.1 Board Dimensions

The dimensions of the board are listed below:

Length: 338mm Width: 122mm 126.39

Figure 2-1: 3307675 Dimensions (mm)

2.1.2 External Interface Panel Dimensions

External peripheral interface connector panel dimensions are shown in Figure 2-2.

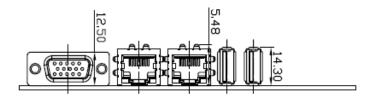


Figure 2-2: External Interface Panel Dimensions (mm)

2.2 Data Flow

Figure 2-3 shows the data flow between the two on-board chipsets and other components installed on the motherboard and described in the following sections of this chapter.

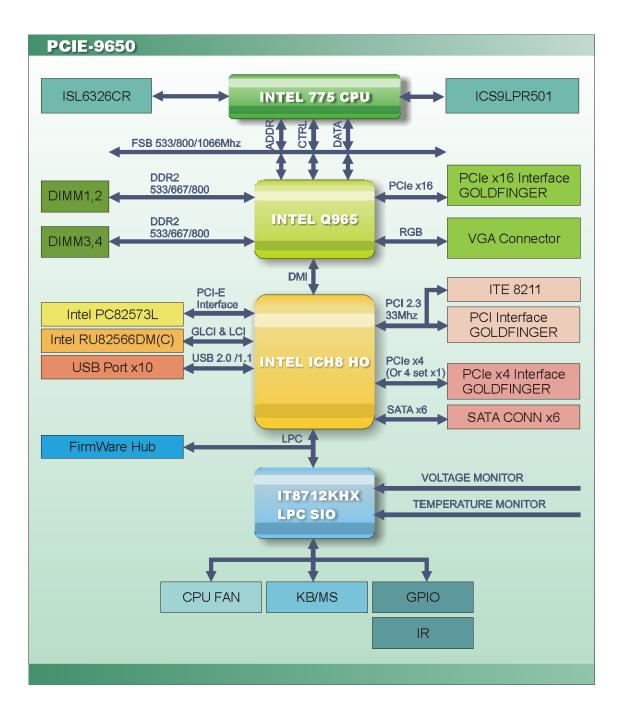


Figure 2-3: Data Flow Block Diagram

2.3 Compatible Processors

The 3307675 supports the following LGA775 processors:

- Intel® Core™2 Quad
- Intel® Core™2 Duo
- Intel® Pentium® D
- Intel® Pentium® 4
- Intel® Celeron® D

All of the above processors are interfaced with an Intel® Q965 northbridge chipset through the front side bus (FSB). Features of the supported processors are listed in sections below.

2.3.1 Intel® Core™2 Quad Features

Intel® Core™2 Quad features include:

- Four processing cores
- Up to 8MB of shared L2 cache
- Up to 1066 MHz FSB
- Intel® Wide Dynamic Execution
- Intel® Intelligent Power Capability
- Intel® Smart Memory Access
- Intel® Advanced Smart Cache
- Intel® Advanced Digital Media Boost

2.3.2 Intel® Core™2 Duo Features

Intel® Core™2 Duo features include:

- Two processing cores
- Up to 8MB of shared L2 cache
- Up to 1066 MHz FSB
- Intel® Wide Dynamic Execution
- Intel® Intelligent Power Capability Intel® Smart Memory Access
- Intel® Advanced Smart Cache
- Intel® Advanced Digital Media Boost

2.3.3 Intel® Pentium® 4 Features

Intel® Pentium® 4 features include:

- Hyper-Threading Technology
- Enhanced Intel SpeedStep® Technology
- Intel® Extended Memory 64 Technology
- Execute Disable Bit

2.3.4 Intel® Pentium® D Features

Intel® Pentium® D features include:

- Dual core processing improves performance and multimedia management
- Intel® Visualization Technology
- Dual 2MB level 2 cache
- 800MHz FSB
- Execute Disable Bit
- Intel® Extended Memory 64 Technology
- Enhanced Intel SpeedStep® Technology
- Streaming SIMD solutions

2.3.5 Intel® Celeron® D Features

Intel® Celeron® D features include:

- Intel® Extended Memory 64 Technology
- 512KB Level 2 cache
- 533MHz FSB
- Execute Disable Bit
- Streaming SIMD solutions

2.4 Intel® Q965 Northbridge Chipset

2.4.1 Intel[®] Q965 Overview

The Intel® Q965 (G)MCH supports LGA775 processors. The (G)MCH supports a FSB frequency of 533 MHz, 800 MHz or 1066 MHz. Some of the features of the Intel® Q965 (G)MCH Include:

- Support for the following processors.
 - O Intel® Core™2 Quad
 - O Intel® Core™2 Duo
 - O Intel® Pentium® D
 - O Intel® Pentium® 4
 - O Intel® Celeron® D
- Supports Hyper-Threading Technology (HT Technology)
- Supports FSB Dynamic Bus Inversion (DBI)
- Supports 36-bit host bus addressing, allowing the processor to access the entire
- 64 GB of the (G)MCH's memory address space
- Has a 12-deep In-Order Queue to support up to twelve outstanding pipelined address requests on the host bus
- Has a 1-deep Defer Queue
- Uses GTL+ bus driver with integrated GTL termination resistors
- Supports a Cache Line Size of 64 bytes

2.4.2 Intel[®] Q965 Memory Support



WARNING:

Only DDR2 memory module can be installed on the 3307675. Do not install DDR memory modules. If a DDR memory module is installed on the 3307675, the 3307675 may be irreparably damaged.

The Intel® Q965 supports up to four 2GB DDR2 DIMMs with the following specifications:

- Only un-buffered DIMMs supported
- DDR2 only
- Maximum supported bandwidth (assuming DDR2 800 MHz):

Single-channel: 6.4 GB/s
 Dual-channel asymmetric mode: 6.4 GB/s
 Dual-channel interleaved mode: 12.8 GB/s

- Capacities of 256MB, 512MB, 1GB or 2GB
- Transfer speeds of 533MHz, 667MHz or 800MHz

The memory sockets are shown in Figure 2-4.

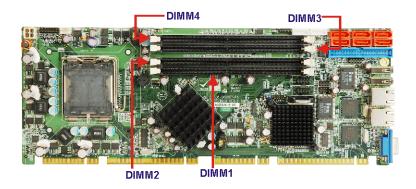


Figure 2-4: 240-pin DIMM Socket

2.4.2.1 Intel® Q965 Analog CRT Support

A DB-15 VGA connector on the external peripheral interface connector panel is interfaced to the Intel[®] Q965 graphics engine. The Intel[®] Q965 internal graphics engine, with an 400MHz integrated 24-bit RAMDAC. Some of the graphics features are listed below.

- Analog Display Support
- 400 MHz Integrated 24-bit RAMDAC
- Up to 2048x1536 @ 75 Hz refresh
- Hardware Color Cursor Support
- DDC2B Compliant Interface

2.4.3 Intel[®] Q965 PCIe x16

2.4.3.1 PCIe x16 Bus Overview

The Intel® Q965 northbridge has on 16-lane PCIe port that is intended for an external PCIe graphics card. The PCIe x16 graphics card is installed on a compatible PICMG 1.3 backplane and interfaced to the northbridge through the two golden fingers shown in **Figure 2-5**. Note that the 16 lanes of the PCIe x16 northbridge bus are connected to two golden fingers.

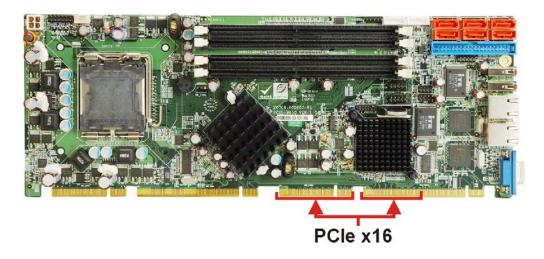


Figure 2-5: PCle x16 Golden Fingers

2.4.3.2 PCle x16 Expansion Options

The PCIe x16 can be interfaced to either one PCIe x16 graphics card or a single PCIe x1 expansion card on a compatible PICMG 1.3 backplane.

2.4.3.3 PCle x16 Bus Specifications

The PCIe port is compliant with the *PCI Express* Base Specification* revision 1.1. The PCIe x16 port operates at a frequency of 2.5 Gb/s on each lane while employing 8b/10b encoding; the port supports a maximum theoretical bandwidth of 40 Gb/s in each direction. Some of the features are listed below.

- One, 16-lane PCIe port intended for graphics attach, compatible to the PCI Express* Base Specification revision 1.1a.
- PCI Express frequency of 1.25 GHz resulting in 2.5 Gb/s each direction

- Raw bit-rate on the data pins of 2.5 Gb/s results in a real bandwidth per pair of 250 MB/s given the 8b/10b encoding used to transmit data across this interface
- Maximum theoretical realized bandwidth on the interface of 4 GB/s in each direction simultaneously, for an aggregate of 8 GB/s when x16.
- PCI Express* Graphics Extended Configuration Space. The first 256 bytes of configuration space alias directly to the PCI Compatibility configuration space. The remaining portion of the fixed 4-KB block of memory-mapped space above that (starting at 100h) is known as extended configuration space.
- PCI Express Enhanced Addressing Mechanism. Accessing the device configuration pace in a flat memory mapped fashion.
- Automatic discovery, negotiation, and training of link out of reset
- Supports traditional PCI style traffic (asynchronous snooped, PCI ordering)
- Supports traditional AGP style traffic (asynchronous non-snooped, PCI Express relaxed ordering)
- Hierarchical PCI-compliant configuration mechanism for downstream devices
 (i.e., normal PCI 2.3 Configuration space as a PCI-to-PCI bridge)
- Supports "static" lane numbering reversal. This method of lane reversal is controlled by a Hardware Reset strap, and reverses both the receivers and transmitters for all lanes (e.g., TX[15]->TX[0], RX[15]->RX[0]). This method is transparent to all external devices and is different than lane reversal as defined in the PCI Express Specification. In particular, link initialization is not affected by static lane reversal.

2.4.4 Intel[®] Q965 Direct Media Interface (DMI)

Intel[®] Q965 northbridge GMCH is connected to the Intel[®] ICH8DO Southbridge Chipset through the chip-to-chip Direct Media Interface (DMI). Features of the Intel[®] Q965 DMI are listed below:

- chip-to-chip connection interface to Intel ICH8
- 2GB/s (1GB/s in each direction) bus speed
- 32-bit downstream address
- 100 MHz reference clock (shared with PCI Express Graphics Attach)
- APIC and MSI interrupt messaging support

- Message Signaled Interrupt (MSI) messages
- SMI, SCI and SERR error indication
- DMA, floppy drive, and LPC bus master

2.5 Intel® ICH8DO Southbridge Chipset

2.5.1 Intel[®] ICH8DO Overview

The Intel® ICH8DO southbridge chipset is connected to the Intel® Q965 northbridge GMCH through the chip-to-chip Direct Media Interface (DMI). Some of the features of the Intel® ICH8DO are listed below.

- Complies with PCI Express Base Specification, Revision 1.1
- Complies with PCI Local Bus Specification, Revision 2.3 and supports 33MHz
 PCI operations
- Supports ACPI Power Management Logic
- Contains:
 - Enhanced DMA controller
 - O Interrupt controller
 - Timer functions
- Integrated SATA host controller with DMA operations and AHCI support interfaced to six SATA connectors on the 3307675
- Supports the eight USB 2.0 devices on the 3307675 with five UHCI controllers and two EHCI controllers
- Integrated 10/100/1000 GbE MAC with System Defense
- Complies with System Management Bus (SMBus) Specification, Version 2.0
- Supports Intel High Definition Audio
- Supports Intel® Matrix Storage Technology
- Supports Intel® Active Management Technology (ICH8DO only)
- Low Pin Count (LPC) interface
- Firmware Hub (FWH) interface support
- Serial Peripheral Interface (SPI) support

2.5.2 Intel[®] High Definition Audio

The 3307675 onboard audio connector can connect to an optional audio kit. The codec on the optional audio kit is connected to the ICH8DO controller through the Intel® High Definition Audio serial link. The DMA engines in the controller move samples of digitally encoded data between system memory and the audio kit codec.

2.5.3 Intel® ICH8DO Low Pin Count (LPC) Interface

The ICH8DO LPC interface complies with the LPC 1.1 specifications. The LPC bus from the ICH8DO is connected to the following components:

- BIOS chipset
- Super I/O chipset

2.5.4 Intel® ICH8DO PCI Interface

The PCI interface on the ICH8DO is compliant with the PCI Revision 2.3 implementation. Some of the features of the PCI interface are listed below.

- PCI Revision 2.3 compliant
- 33MHz
- 5V tolerant PCI signals (except PME#)
- Integrated PCI arbiter supports up to seven PCI bus masters

The PCI bus is connected to an interface gold finger on the bottom of the CPU cards and supports four expansion PCI cards on the backplane. The PCI interface bus is also connected to an IDE controller to provide connectivity to IDE HDDs. For more details please refer to **Section 2.7**.

2.5.5 Intel® ICH8DO PCIe Ports

There are six root PCIe ports on the Intel® ICH8DO. Port 5 and port 6 provides PCIe x1 connectivity to the Intel® PC82573L PCIe GbE controller. Port 1 to port 4 is connected to the golden finger that is installed on a compatible socket in a PICMG v1.3 compatible

backplane. This enables up to four PCIe x1 or one PCI x4 compatible expansion boards to be installed on the backplane.

2.5.6 Intel® ICH8DO Low Pin Count (LPC) Interface

The ICH8DO LPC interface complies with the LPC 1.1 specifications. The LPC bus from the ICH8DO is connected to the following components:

- BIOS chipset
- Super I/O chipset

2.5.7 Intel® ICH8DO PCI Interface

The PCI interface on the Intel® ICH8DO is compliant with the PCI Revision 2.3 implementation. Some of the features of the PCI interface are listed below.

- PCI Revision 2.3 compliant
- 33MHz
- 5V tolerant PCI signals (except PME#)
- Integrated PCI arbiter supports up to seven PCI bus masters

2.5.8 Intel® ICH8DO Real Time Clock

256 bytes of battery backed RAM is provided by the Motorola MC146818A real time clock (RTC) integrated into the ICH8DO. The RTC operates on a 3V battery and 32.768KHz crystal. The RTC keeps track of the time and stores system data even when the system is turned off.

2.5.9 Intel® ICH8DO SATA Controller

The two integrated SATA controllers on the ICH8DO southbridge support six SATA II drives on the 3307675 with independent DMA operations. The SATA controller contains two modes of operation – a legacy mode using I/O space, and an AHCI mode using memory space. SATA controller specifications are listed below.

- Supports independent DMA operation on up to six ports
- Supports six SATA drives

- Supports 3Gb/s data transfer speeds
- Supports Serial ATA 1.0 Specification, Revision 1.0



Figure 2-6: SATA Connectors

2.5.10 Intel® ICH8DO USB Controller

Up to six high-speed, full-speed or low-speed USB devices are supported by the ICH8DO on the 3307675. High-speed USB 2.0, with data transfers of up to 480MB/s, is enabled with the ICH8DO integrated Enhanced Host Controller Interface (EHCI) compliant host controller. USB full-speed and low-speed signaling is supported by the ICH8DO integrated Universal Host Controller Interface (UHCI) controllers.

2.6 Intel® ICH8DO PCIe Bus Components

2.6.1 PCIe Bus Overview

The PCIE-9659 Intel® ICH8DO southbridge PCIe bus is split into two PCIe x1 channels and one PCIe x4 channel. One PCIe x1 channel is connected to a PCIe Gigabit Ethernet (GbE) controller. The PCIe x4 channel is connected to a golden finger on the bottom of the CPU card. The remaining PCIe x1 channel is shared with the GLCI (Gigabit LAN Connect Interface) bus which is in turn connected to a GbE controller.

2.6.2 PCIe x4 Interface Goldfinger

The PCIe x4 from the southbridge consists of four lanes. The four lanes are connected to a single golden finger as shown in **Figure 2-7**.



Figure 2-7: PCIe x4 Golden Finger Connection

The PCIe x4 is interfaced to one PCIe x4 expansion card or four PCIe x1 expansion cards on a compatible PICMG 1.3 backplane.

2.6.3 PCle Gigabit Ethernet (GbE) Controller

There is one Intel® PC82573L PCIe GbE controller installed on the 3307675. The Intel® PC82573L is interfaced through a PCIe x1 channel to the Intel® ICH8DO. The Intel® PC82573L controller is then connected to an RJ-45 Ethernet connector enabling the 3307675 to be connected to an external network.



PCIe GbE Controllers

Figure 2-8: Ethernet Controllers

The Intel® PC82573L controller is a low power 10/100/1000 Mbps PCIe GbE controller that is ideal for non-managed platforms. Some of the Intel® PC82573L features are listed below.

- 2 Gbps peak bandwidth per direction
- PCI Express Rev 1.0a specification
- Wide, pipelined internal data path architecture
- Optimized transmit (Tx) and receive (Rx) queues
- 32 KB configurable Rx and Tx first-in/first-out (FIFO)
- IEEE 802.3x*-compliant flow-control support with software controllable pause times and threshold values
- Programmable host memory Rx buffers (256 B-16 KB)
- Descriptor ring management hardware for Tx and Rx
- Mechanism for reducing interrupts from Tx/Rx operations
- Integrated PHY for 10/100/1000 Mbps (full- and half-duplex)
- IEEE 802.3ab* auto-negotiation support
- IEEE 802.3ab PHY compliance and compatibility
- Tx/Rx IP, TCP, and UDP checksum offloading
- Tx TCP segmentation

2.7 PCI Bus Components

2.7.1 PCI Bus Overview

The 33MHz PCI bus connects the Intel® southbridge to the components listed below.

- ITE 8211 ATA controller chipset
- PCI interface goldfinger

2.7.2 ITE 8211 ATA Controller Chipset

The 40-pin IDE connector on the 3307675 is connected to the ATA/ATAPI-6 ITE 8211 ATA controller chipset, which is then connected to the Intel® ICH8DO southbridge chipset. The controller and connector are shown in **Figure 2-9** below.

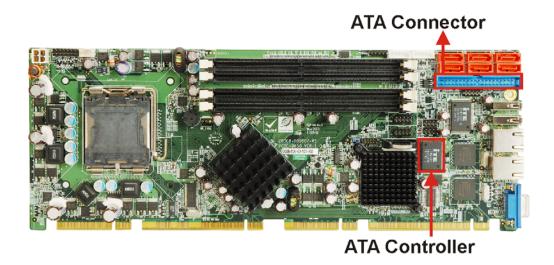


Figure 2-9: ATA controller

Two ATA/ATAPI-6 hard disks can be connected to the IDE connector. Specifications for the ITE 8211 are listed below.

- Compatible with ATA/ATAPI-6 specifications
- Supports ANSI ATA proposal PIO modes 0, 1, 2, 3, and 4 with flow control,
 DMA modes 0, 1, and 2 and Ultra DMA modes 0, 1, 2, 3, 4, 5 and 6.
- 512 bytes FIFO for data transfer per IDE channel

Supports pre-fetch and post-write function for PIO mode.

2.7.3 PCI Interface Goldfinger

The PCI interface goldfinger is connected to the PCI bus on the backplane and connects the PCI backplane expansion boards with connectivity to the Intel® ICH8DO. The PCI bus golden finger is shown in **Figure 2-7**.



Figure 2-10: PCI Golden Finger Connection

The PCI is interfaced to four standard PCI expansion cards a compatible PICMG 1.3 backplane.

2.8 LPC Bus Components

2.8.1 LPC Bus Overview

The LPC bus is connected to components listed below:

- BIOS chipset
- Super I/O chipset

2.8.2 BIOS Chipset

The BIOS chipset has a licensed copy of AMI BIOS installed on the chipset. Some of the BIOS features are listed below:

- AMI Flash BIOS
- SMIBIOS (DMI) compliant
- Console redirection function support
- PXE (Pre-boot Execution Environment) support
- USB booting support

2.8.3 Super I/O chipset

The iTE IT8712F Super I/O chipset is connected to the ICH8DO southbridge through the LPC bus. The iTE IT8712F is an LPC interface-based Super I/O device that comes with Environment Controller integration. Some of the features of the iTE IT8712F chipset are listed below:

- PC98/99/2001, ACPI and LANDesk Compliant
- Enhanced Hardware Monitor
- Fan Speed Controller
- Single +5V Power Supply
- Two 16C550 UARTs for serial port control
- One IEEE 1284 Parallel Port
- Keyboard Controller
- Watchdog Timer
- Serial IRQ Support
- Vbat & Vcch Support
- Single +5V Power Supply

Some of the Super I/O features are described in more detail below:

2.8.3.1 Super I/O LPC Interface

The LPC interface on the Super I/O complies with the Intel[®] Low Pin Count Specification Rev. 1.0. The LPC interface supports both LDRQ# and SERIRQ protocols as well as PCI PME# interfaces.

2.8.3.2 Super I/O 16C550 UARTs

The onboard Super I/O has two integrated 16C550 UARTs that can support the following:

- Two standard serial ports (COM1 and COM2)
- IrDa 1.0 and ASKIR protocols

Another two chipsets connected to the LPC bus provided connectivity to another two serial port connectors (COM3 and COM4).

2.8.3.3 Super I/O Enhanced Hardware Monitor

The Super I/O Enhanced Hardware Monitor monitors three thermal inputs, VBAT internally, and eight voltage monitor inputs. These hardware parameters are reported in the BIOS and can be read from the BIOS Hardware Health Configuration menu.

2.8.3.4 Super I/O Fan Speed Controller

The Super I/O fan speed controller enables the system to monitor the speed of the fan. One of the pins on the fan connector is reserved for fan speed detection and interfaced to the fan speed controller on the Super I/O. The fan speed is then reported in the BIOS.

2.8.3.5 Super I/O Keyboard Controller

The Super I/O keyboard controller can execute the 8042 instruction set. Some of the keyboard controller features are listed below:

- The 8042 instruction is compatible with a PS/2 keyboard and PS/2 mouse
- Gate A20 and Keyboard reset output
- Supports multiple keyboard power on events
- Supports mouse double-click and/or mouse move power on events

2.9 Environmental and Power Specifications

2.9.1 System Monitoring

Three thermal inputs on the 3307675 Super I/O Enhanced Hardware Monitor monitor the following temperatures:

- System temperature
- Power temperature
- CPU temperature

Eight voltage inputs on the 3307675 Super I/O Enhanced Hardware Monitor monitor the following voltages:

- Vcore
- +2.5V
- +3.3V
- +5.0V
- +12.0V
- DDR Vtt
- +1.5V
- 5VSB

The 3307675 Super I/O Enhanced Hardware Monitor also monitors the following voltages internally:

VBAT

The 3307675 Super I/O Enhanced Hardware Monitor also monitors the following fan speeds:

CPU Fan speed

The values for the above environmental parameters are all recorded in the BIOS Hardware Health Configuration menu.

2.9.2 Operating Temperature and Temperature Control

The maximum and minimum operating temperatures for the 3307675 are listed below.

Minimum Operating Temperature: 0°C (32°F)

Maximum Operating Temperature: 60°C (140°F)

A cooling fan and heat sink must be installed on the CPU. Thermal paste must be smeared on the lower side of the heat sink before it is mounted on the CPU. Heat sinks are also mounted on the northbridge and southbridge chipsets to ensure the operating temperature of these chips remain low.

2.9.3 Power Consumption

Table 2-1 shows the power consumption parameters for the 3307675 running with a 2.66GHz Intel[®] Core[®] 2 Extreme QX6700 processor with 4GB of 800MHz DDR2 memory.

Voltage	Current
+3.3V	6.42
+5V	8.93A
+12V	7.42A

Table 2-1: Power Consumption

2.10 Expansion Options

2.10.1 Expansion Options Overview

A number of compatible Global American, Inc. PICMG 1.3 backplanes and chassis can be used to develop and expanded system. These backplanes and chassis are listed below.

2.10.2 GLOBAL AMERICAN, INC. Expansion PICMG 1.3 Backplanes

The backplanes listed in **Table 2-2** are compatible with the 3307675 and can be used to develop highly integrated industrial applications. All of the backplanes listed below have 24-pin ATX connector and a 4-pin ATX connector. For more information about these backplanes please consult the GLOBAL AMERICAN, INC. catalog or contact your vendor, reseller or the GLOBAL AMERICAN, INC. sales team at salesinfo@globalamericaninc.com.

			Expansion Slots ystem PCle PCI				
Model	Total Slots	System			DCI	System Type	
			x16	х4	x1	PCI	
1107790	4	One	1	1	-	1	Single
1107780	4	One	1	-	-	2	Single
1107800	4	One	1	-	2	-	Single
1107810	5	One	1	1	-	2	Single
1107820	5	One	1	-	3	-	Single
1107740	6	One	1	-	-	3	Single
1107840	6	One	1	1	-	3	Single
1107770	6	One	1	-	3	1	Single
1107750	5	One	1	-	3	-	Single
1107850	5	One	1	-	2	1	Single
1107860	7	One	1	-	2	3	Single
1107870	7	One	1	-	4	1	Single
1107880	8	One	1	-	3	3	Single
1107890	9	One	1	-	4	3	Single
1107900	10	One	1	-	4	4	Single
1107910	10	One	1	-	4	4	Single
1107920	13	One	1	1	-	2	Dual
1107920	13	Two	1	-	4	2	Duai
1107930	13	One	1	-	3	8	Single
1107940	19	One	1	-	1	16	Single
Table 2-2: Compatible GLOBAL AMERICAN PICMG 1.3 Backplanes							

2.10.3 GLOBAL AMERICAN, INC. Chassis

GLOBAL AMERICAN, INC. chassis available for 3307675 system development are listed in **Table 2-3**.

For more information about these chassis please consult the GLOBAL AMERICAN, INC. catalog or contact your vendor, reseller or the GLOBAL AMERICAN, INC. sales team at salesinfo@globalamericaninc.com.

Model	Slot SBC	Mounting	Max Slots	Backplanes
1407460	Full-size	Wall	4	1107790
				1107780
				1107800
1401422	Full-size	Wall	6	1107810
				1107820
				1107840
				1107770
1404540	Full-size	Wall	6	1107810
				1107820
				1104840
				1107770
1404580	Full-size	Rack	14	1107740
	(4U)			1107900
				1107910
				1107920
				1107930
				1107940
1404600	Full-size	Rack	14	1107740
	(4U)			1107900
				1107910
				1107920
				1107930
1407670	Full-size	Rack	14	1107740
	(4U)			1107900
				1107910
				1107920
				1107930
1404150	Full-size	Rack	14	1107740
	(4U)			1107900
				1107910
				1107920
				1107930
				1107940

Model	Slot SBC	Mounting	Max Slots	Backplanes
1401032	Full-size	Wall	7	1107740
				1107860
				1107870
1401412	Full-size	Wall	10	1107740
				1107880
1407660	Full-size	Wall	6	1107840
				1107770
1404570	Full-size	Rack	6	1107750
	(2U)			1107850
1404552	Full-size	Rack	6	1107750
	(2U)			1107850

Table 2-3: Compatible GLOBAL AMERICAN Chassis

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Chapter

3

Unpacking

3.1 Anti-static Precautions



WARNING-

Failure to take ESD precautions during the installation of the 3307675 may result in permanent damage to the 3307675 and severe injury to the user.

Electrostatic discharge (ESD) can cause serious damage to electronic components, including the 3307675. Dry climates are especially susceptible to ESD. It is therefore critical that whenever the 3307675, or any other electrical component is handled, the following anti-static precautions are strictly adhered to.

- Wear an anti-static wristband: Wearing a simple anti-static wristband can help to prevent ESD from damaging the board.
- **Self-grounding**:- Before handling the board touch any grounded conducting material. During the time the board is handled, frequently touch any conducting materials that are connected to the ground.
- **Use an anti-static pad**: When configuring the 3307675, place it on an antic-static pad. This reduces the possibility of ESD damaging the 3307675.
- Only handle the edges of the PCB:-: When handling the PCB, hold the PCB by the edges.

3.2 Unpacking

3.2.1 Unpacking Precautions

When the 3307675 is unpacked, please do the following:

- Follow the anti-static precautions outlined in **Section 3.1**.
- Make sure the packing box is facing upwards so the 3307675 does not fall out of the box.
- Make sure all the components shown in **Section 3.3** are present.

3.3 Unpacking Checklist



NOTE:

If some of the components listed in the checklist below are missing, please do not proceed with the installation. Contact the GLOBAL AMERICAN, INC. reseller or vendor you purchased the 3307675 from or contact a Global American sales representative directly. To contact a Global American sales representative, please send an email to salesinfo@globalamericaninc.com.

3.3.1 Package Contents

The 3307675 is shipped with the following components:

Quantity	Item and Part Number	Image
1	3307675	
1	ATA 66/100 flat cable	
1	Dual RS-232 cable	

6	SATA cables	
3	SATA power cables	420
1	Mini jumper Pack	
1	Quick Installation Guide	ENTIL OF PRIORISES
1	Utility CD	iEi
1	USB cable	

Table 3-1: Package List Contents

3.4 Optional Items

Audio kit (P/N : 1007760)	
5-pin Wafer-to-PS/2 (P/N : 1208370)	
4-port USB cable (P/N : 1207689)	
CPU cooling kit (P/N: 2107695	
PCIe x16 VGA output SDVO card with dual display support (P/N: 3907690)	
PCIe x16 DVI output SDVO card with dual display support (P/N: 3907680)	

Table 3-2: Package List Contents

Chapter _

4

Connector Pinouts

4.1 Peripheral Interface Connectors

Section 4.1.2 shows peripheral interface connector locations. Section 4.1.2 lists all the peripheral interface connectors seen in Section 4.1.2.

4.1.1 3307675 Layout

Figure 4-1 shows the on-board peripheral connectors, rear panel peripheral connectors and on-board jumpers.

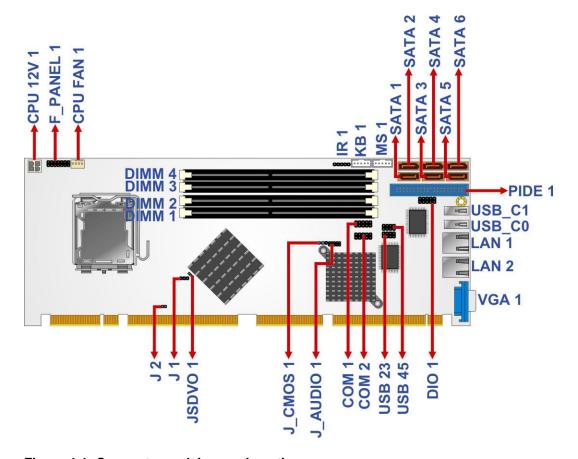


Figure 4-1: Connector and Jumper Locations

4.1.2 Peripheral Interface Connectors

Table 4-1 shows a list of the peripheral interface connectors on the WAFER-LX. Detailed descriptions of these connectors can be found below.

Connector	Туре	Label
ATX power connector	4-pin header	CPU12V1
Audio connector	9-pin header	J_AUDIO1
Cooling fan connector	4-pin header	CPU_FAN1
Digital input/output connector	10-pin header	DIO1
Front panel connector	10-pin header	F_PANEL1
IDE Interface connector	40-pin box header	PIDE1
Infrared (IrDA) connector	5-pin header	IR1
Keyboard connector	5-pin wafer	KB1
Mouse connector	5-pin wafer	MS1
Serial ATA drive connector	7-pin SATA	SATA1
Serial ATA drive connector	7-pin SATA	SATA2
Serial ATA drive connector	7-pin SATA	SATA3
Serial ATA drive connector	7-pin SATA	SATA4
Serial ATA drive connector	7-pin SATA	SATA5
Serial ATA drive connector	7-pin SATA	SATA6
Serial port connector (COM1)	10-pin header	COM1
Serial port connector (COM2)	10-pin header	COM2
USB connectors	8-pin header	USB23
USB connectors	8-pin header	USB45

Table 4-1: Peripheral Interface Connectors

4.1.3 External Interface Panel Connectors

Table 4-2 lists the rear panel connectors on the WAFER-LX. Detailed descriptions of these connectors can be found in **Section** Error! Reference source not found. on **page** Error! Bookmark not defined.

Connector	Туре	Label
Ethernet connector	RJ-45	LAN1
Ethernet connector	RJ-45	LAN2
USB port	USB port	USB_C0
USB port	USB port	USB_C1
VGA port connector	15-pin female	VGA

Table 4-2: Rear Panel Connectors

4.2 Internal Peripheral Connectors

Internal peripheral connectors are found on the motherboard and are only accessible when the motherboard is outside of the chassis. This section has complete descriptions of all the internal, peripheral connectors on the 3307675.

4.2.1 ATX Power Connector

CN Label: CPU12V1

CN Type: 4-pin ATX power connector (2x2)

CN Location: See Figure 4-2

CN Pinouts: See Table 4-3

The 4-pin ATX power connector is connected to an ATX power supply.

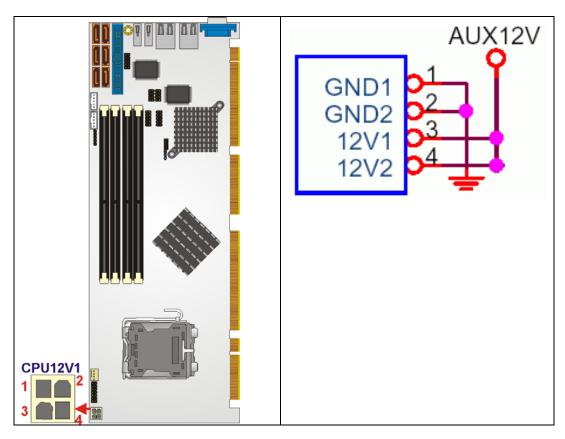


Figure 4-2: ATX Power Connector Location

PIN NO.	DESCRIPTION
1	GND
2	GND
3	+12V
4	+12V

Table 4-3: ATX Power Connector Pinouts

4.2.2 Audio Connector

CN Label: J_AUDIO1

CN Type: 10-pin header (2x5)

CN Location: See Figure 4-3

CN Pinouts: See Table 4-4

The 10-pin audio connector is connected to external audio devices including speakers and microphones for the input and output of audio signals to and from the system.

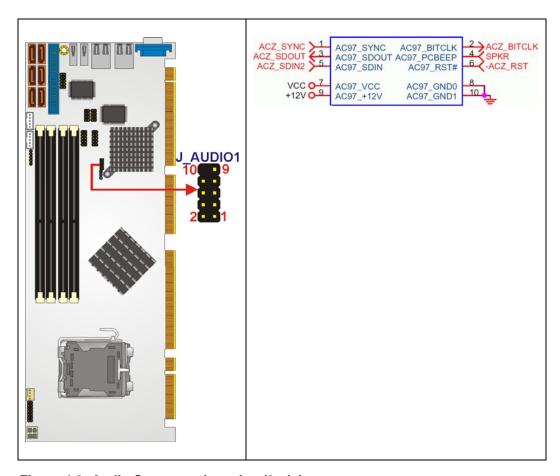


Figure 4-3: Audio Connector Location (9-pin)

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	SYNC	2	BITCLK
3	SDOUT	4	PCBEEP
5	SDIN	6	RST#
7	vcc	8	GND
9	+12V	10	GND

Table 4-4: Audio Connector Pinouts

4.2.3 Digital Input/Output (DIO) Connector

CN Label: DIO1

CN Type: 10-pin header (2x5)

CN Location: See Figure 4-4

CN Pinouts: See Table 4-5

The digital input/output connector is managed through a Super I/O chip. The DIO connector pins are user programmable.

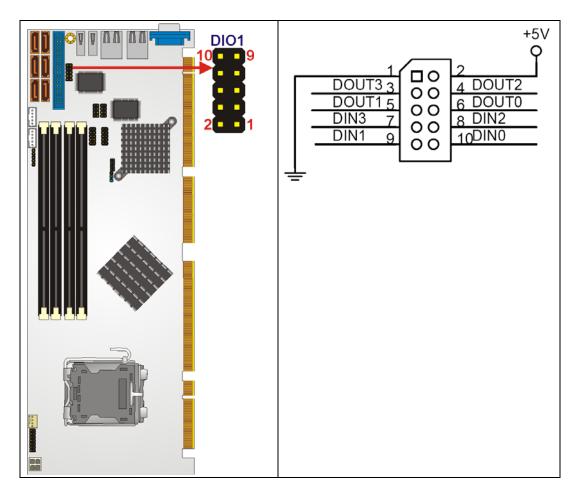


Figure 4-4: DIO Connector Connector Locations

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	GND	2	vcc
3	Output 3	4	Output 2
5	Output 1	6	Output 0
7	Input 3	8	Input 1
9	Input 1	10	Input 0

Table 4-5: DIO Connector Connector Pinouts

4.2.4 Fan Connector (+12V)

CN Label: CPU_FAN1

CN Type: 4-pin header

CN Location: See Figure 4-5

CN Pinouts: See Table 4-6

The cooling fan connector provides a 12V, 500mA current to a system cooling fan. The connector has a "rotation" pin to get rotation signals from fans and notify the system so the system BIOS can recognize the fan speed. Please note that only specified fans can issue the rotation signals.

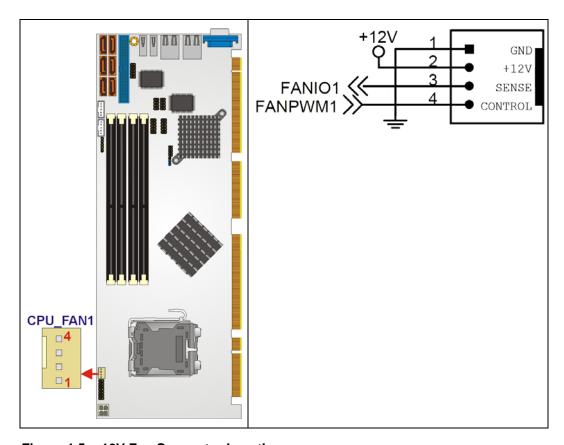


Figure 4-5: +12V Fan Connector Location

PIN NO.	DESCRIPTION	
1	GND	
2	+12V	
3	Rotation Signal	
4	Control	

Table 4-6: +12V Fan Connector Pinouts

4.2.5 Front Panel Connector (14-pin)

CN Label: F_PANEL1

CN Type: 12-pin header (2x6)

CN Location: See Figure 4-6

CN Pinouts: See Table 4-7

The front panel connector connects to external switches and indicators to monitor and controls the motherboard. These indicators and switches include:

- Power LED
- Speaker
- Power button
- Reset
- HDD LED

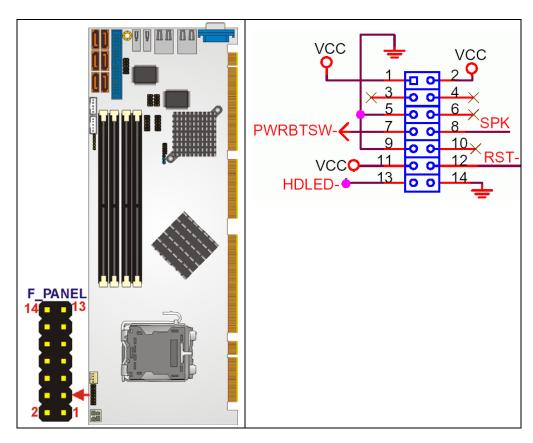


Figure 4-6: Front Panel Connector Pinout Locations (14-pin)

FUNCTION	PIN	DESCRIPTION	FUNCTION	PIN	DESCRIPTION
Power	1	LED+	Speaker	2	+5V
LED	3	N/C		4	N/C

	5	GND		6	N/C
Power	7	PWRBTSW+		8	Speaker
Button	9	PWRBTSW-	Reset	10	N/C
HDD LED	11	+5V		12	RESET-
	13	HDD LED-		14	GND

Table 4-7: Front Panel Connector Pinouts (14-pin)

4.2.6 IDE Connector (40-pin)

CN Label: PIDE1

CN Type: 40-pin header (2x20)

CN Location: See Figure 4-7

CN Pinouts: See Table 4-8

One 40-pin IDE device connector on the 3307675 supports connectivity to two hard disk drives.

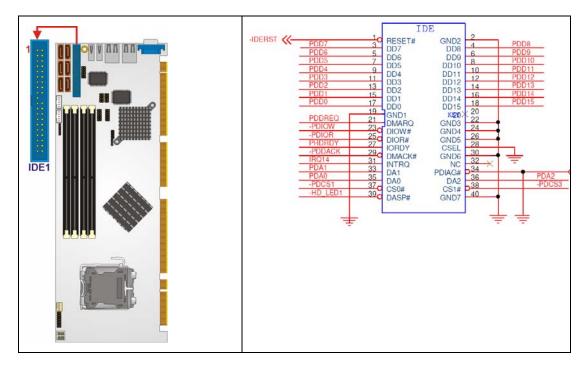


Figure 4-7: IDE Device Connector Locations

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION	
1	RESET#	2	GROUND	
3	DATA 7	4	DATA 8	
5	DATA 6	6	DATA 9	
7	DATA 5	8	DATA 10	
9	DATA 4	10	DATA 11	
11	DATA 3	12	DATA 12	
13	DATA 2	14	DATA 13	
15	DATA 1	16	DATA 14	
17	DATA O	18	DATA 15	
19	GROUND	20	N/C	
21	IDE DRQ	22	GROUND	
23	IOW#	24	GROUND	
25	IOR#	26	GROUND	
27	IDE CHRDY	28	GROUND	
29	IDE DACK	30	GROUND-DEFAULT	
31	INTERRUPT	32	N/C	
33	SA1	34	N/C	
35	SAO	36	SA2	
37	HDC CSO#	38	HDC CS1#	
39	HDD ACTIVE#	40	GROUND	

Table 4-8: IDE Connector Pinouts

4.2.7 Infrared Interface Connector (5-pin)

CN Label: CN19

CN Type: 5-pin header (1x5)

CN Location: See Figure 4-8

CN Pinouts: See Table 4-9

The infrared interface connector supports both Serial Infrared (SIR) and Amplitude Shift Key Infrared (ASKIR) interfaces.

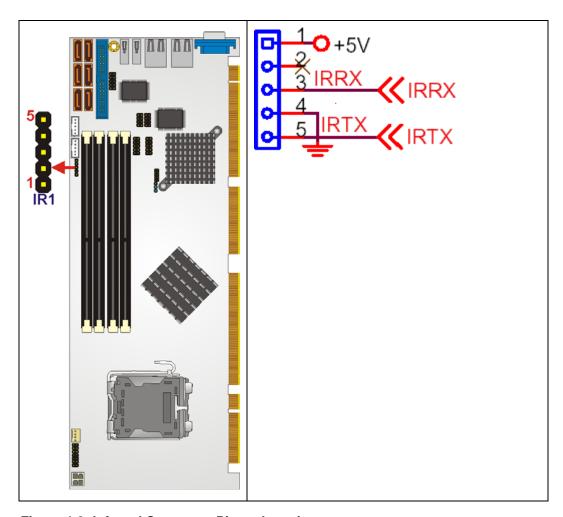


Figure 4-8: Infrared Connector Pinout Locations

PIN NO.	DESCRIPTION	
1	vcc	
2	NC	
3	IR-RX	
4	GND	
5	IR-TX	

Table 4-9: Infrared Connector Pinouts

4.2.8 Keyboard Connector

CN Label: KB1

CN Type: 5-pin header (1x5)

CN Location: See Figure 4-9

CN Pinouts: See Table 4-10

The keyboard connector can be connected to a standard PS/2 cable to add keyboard functionality to the system.

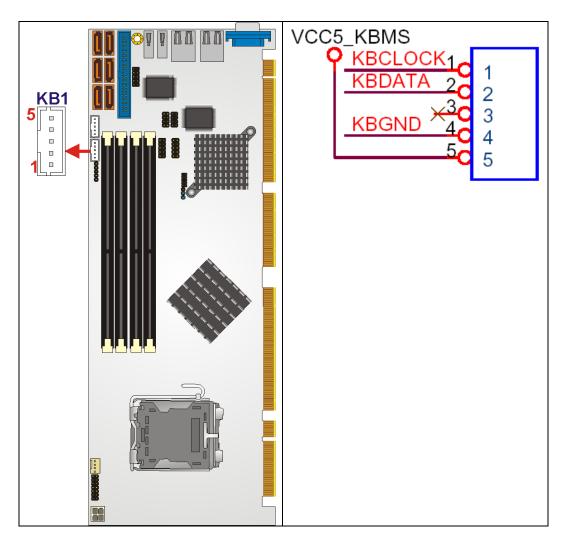


Figure 4-9: Keyboard Connector Location

PIN NO.	DESCRIPTION	
1	KEYBOARD CLOCK	
2	KEYBOARD DATA	
3	N/C	

4	GROUND
5	vcc

Table 4-10: Keyboard Connector Pinouts

4.2.9 Mouse Connector

CN Label: MS1

CN Type: 5-pin header (1x5)

CN Location: See Figure 4-9

CN Pinouts: See Table 4-10

The mouse connector can be connected to a standard PS/2 cable to add keyboard and mouse functionality to the system.

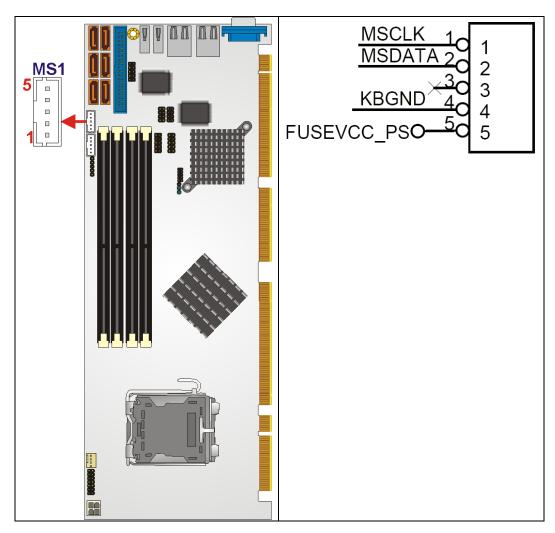


Figure 4-10: Mouse Connector Location

PIN NO.	DESCRIPTION
1	MOUSE CLOCK
2	MOUSE DATA
3	N/C
4	GROUND
5	vcc

Table 4-11: Mouse Connector Pinouts

4.2.10 SATA Drive Connectors

CN Label: SATA1, SATA2, SATA3, SATA4, SATA5 and SATA6

CN Type: 7-pin SATA drive connectors

CN Location: See Figure 4-11

CN Pinouts: See Table 4-12

The two SATA drive connectors are each connected to a first generation SATA drive. First generation SATA drives transfer data at speeds as high as 150Mb/s. The SATA drives can be configured in a RAID configuration.

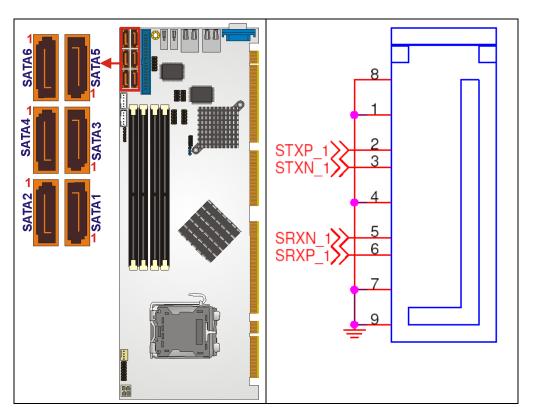


Figure 4-11: SATA Drive Connector Locations

PIN NO.	DESCRIPTION
1	GND
2	TX+
3	TX-
4	GND
5	RX-
6	RX+

7	GND
---	-----

Table 4-12: SATA Drive Connector Pinouts

4.2.11 Serial Port Connector (COM1 and COM2)

CN Label: COM1 and COM2

CN Type: 10-pin header (2x5)

CN Location: See Error! Reference source not found.

CN Pinouts: See Error! Reference source not found.

The 10-pin serial port connector provides a second RS-232 serial communications channel. The COM 2 serial port connector can be connected to external RS-232 serial port devices.

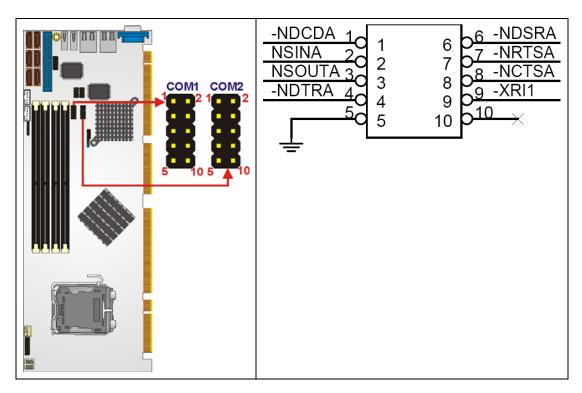


Figure 4-12: COM 2 Connector Pinout Locations

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	NDCD	6	NDSR
2	NSIN	7	NRTS
3	NSOUT	8	NCTS
4	NDTR	9	XRI
5	Ground (GND)	10	

Table 4-13: COM1 and COM2 Connector Pinouts

4.2.12 USB Connectors (Internal)

CN Label: USB23, USB45

CN Type: 8-pin header (2x4)

CN Location: See Figure 4-13

CN Pinouts: See Table 4-14

The 2x4 USB pin connectors each provide connectivity to two USB 1.1 or two USB 2.0 ports. Each USB connector can support two USB devices. Additional external USB ports are found on the rear panel. The USB ports are used for I/O bus expansion.

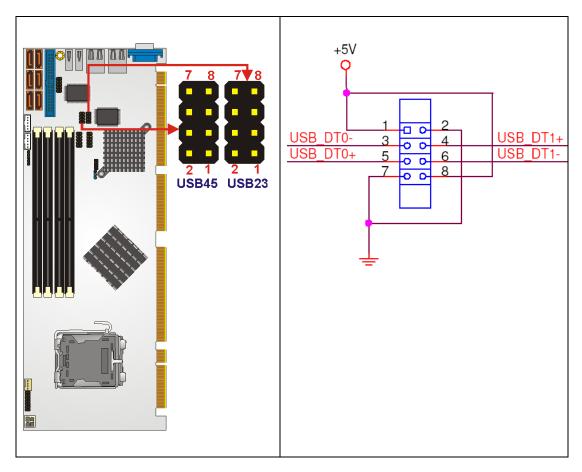


Figure 4-13: USB Connector Pinout Locations

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	vcc	2	GND
3	DATAN-	4	DATAM+
5	DATAN+	6	DATAM-
7	GND	8	VCC

Table 4-14: USB Port Connector Pinouts

4.3 External Peripheral Interface Connector Panel

Figure 4-14 shows the 3307675 external peripheral interface connector (EPIC) panel. The 3307675 EPIC panel consists of the following:

- 2 x RJ-45 LAN connectors
- 2 x USB connectors

■ 1 x VGA connector

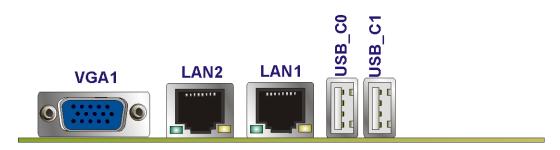


Figure 4-14: 3307675 External Peripheral Interface Connector

4.3.1 LAN Connectors

CN Label: LAN1 and LAN2

CN Type: RJ-45

CN Location: See Figure 4-14

CN Pinouts: See Table 4-15

The 3307675 is equipped with two built-in RJ-45 Ethernet controllers. The controllers can connect to the LAN through two RJ-45 LAN connectors. There are two LEDs on the connector indicating the status of LAN. The pin assignments are listed in the following table:

PIN	DESCRIPTION	PIN	DESCRIPTION
1	TXA+	5	TXC-
2	TXA-	6	TXB-
3	TXB+	7	TXD+
4	TXC+	8	TXD-

Table 4-15: LAN Pinouts



Figure 4-15: RJ-45 Ethernet Connector

The RJ-45 Ethernet connector has two status LEDs, one green and one yellow. The green LED indicates activity on the port and the yellow LED indicates the port is linked. See **Table 4-16**.

STATUS	DESCRIPTION	STATUS	DESCRIPTION
GREEN	Activity	YELLOW	Linked

Table 4-16: RJ-45 Ethernet Connector LEDs

4.3.2 USB Connector

CN Label: USB_C1 and USB_C0

CN Type: USB ports

CN Location: See Figure 4-14

CN Pinouts: See Table 4-17

The 3307675 has four external USB 2.0 ports. The ports connect to both USB 2.0 and USB 1.1 devices.

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	USBV3L 5V	1	USBV3L 5V
2	USBP4N	2	USBP5N
3	USBP4P	3	USBP5P
4	GND	4	GND

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
---------	-------------	---------	-------------

Table 4-17: USB Port Pinouts

4.3.3 VGA Connector

CN Label: VGA1

CN Type: 15-pin Female

CN Location: See Figure 4-14

CN Pinouts: See Figure 4-16 and Table 4-18

The 3307675 has a single 15-pin female connector for connectivity to standard display devices.

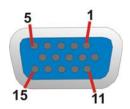


Figure 4-16: VGA Connector

PIN	DESCRIPTION	PIN	DESCRIPTION
1	RED	2	GREEN
3	BLUE	4	NC
5	GND	6	GND
7	GND	8	GND
9	VCC / NC	10	GND
11	NC	12	DDC DAT
13	HSYNC	14	VSYNC
15	DDCCLK		

Table 4-18: VGA Connector Pinouts

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Chapter 5

Installation

5.1 Anti-static Precautions



WARNING:

Failure to take ESD precautions during the installation of the 3307675 may result in permanent damage to the 3307675 and severe injury to the user.

Electrostatic discharge (ESD) can cause serious damage to electronic components, including the 3307675. Dry climates are especially susceptible to ESD. It is therefore critical that whenever the 3307675, or any other electrical component is handled, the following anti-static precautions are strictly adhered to.

- Wear an anti-static wristband: Wearing a simple anti-static wristband can help to prevent ESD from damaging the board.
- Self-grounding:- Before handling the board touch any grounded conducting material. During the time the board is handled, frequently touch any conducting materials that are connected to the ground.
- **Use an anti-static pad**: When configuring the 3307675, place it on an antic-static pad. This reduces the possibility of ESD damaging the 3307675.
- Only handle the edges of the PCB:-: When handling the PCB, hold the PCB by the edges.

5.2 Installation Considerations



NOTE:

The following installation notices and installation considerations should be read and understood before the 3307675 is installed. All installation notices pertaining to the installation of the 3307675 should be strictly adhered to. Failing to adhere to these precautions may lead to severe damage of the 3307675 and injury to the person installing the motherboard.

5.2.1 Installation Notices



WARNING:

The installation instructions described in this manual should be carefully followed in order to prevent damage to the 3307675, 3307675 components and injury to the user.

Before and during the installation please **DO** the following:

- Read the user manual:
 - The user manual provides a complete description of the 3307675 installation instructions and configuration options.
- Wear an electrostatic discharge cuff (ESD):
 - Electronic components are easily damaged by ESD. Wearing an ESD cuff removes ESD from the body and helps prevent ESD damage.
- Place the 3307675 on an antistatic pad:
 - O When installing or configuring the motherboard, place it on an antistatic pad. This helps to prevent potential ESD damage.
- Turn all power to the 3307675 off:

O When working with the 3307675, make sure that it is disconnected from all power supplies and that no electricity is being fed into the system.

Before and during the installation of the 3307675 **DO NOT:**

- Remove any of the stickers on the PCB board. These stickers are required for warranty validation.
- Use the product before verifying all the cables and power connectors are properly connected.
- Allow screws to come in contact with the PCB circuit, connector pins, or its components.

5.2.2 Installation Checklist

The following checklist is provided to ensure the 3307675 is properly installed.

- All the items in the packing list are present
- The CPU is installed
- The CPU cooling kit is properly installed
- A compatible memory module is properly inserted into the slot
- The CF Type I or CF Type II card is properly installed into the CF socket
- The jumpers have been properly configured
- The 3307675 is inserted into a chassis with adequate ventilation
- The correct power supply is being used
- The following devices are properly connected
 - O Primary and secondary IDE device
 - O SATA drives
 - O Keyboard and mouse cable
 - O Audio kit
 - O Power supply
 - O USB cable
 - O Serial port cable
 - Parallel port cable
- The following external peripheral devices are properly connected to the chassis:
 - O VGA screen

- Keyboard
- O Mouse
- RS-232 serial communications device
- Parallel port

5.3 Unpacking

5.3.1 Unpacking Precautions

When the 3307675 is unpacked, please do the following:

- Follow the anti-static precautions outlined in **Section 5.1**.
- Make sure the packing box is facing upwards so the 3307675 does not fall out of the box.
- Make sure all the components in the checklist shown in Chapter 3 are present.



NOTE:

If some of the components listed in the checklist in **Chapter 3** are missing, please do not proceed with the installation. Contact the GLOBAL AMERICAN, INC. reseller or vendor you purchased the 3307675 from or contact a Global American sales representative directly. To contact a Global American sales representative, please send an email to salesinfo@globalamericaninc.com.

5.4 CPU, CPU Cooling Kit and DIMM Installation



WARNING:

A CPU should never be turned on without the specified cooling kit being installed. If the cooling kit (heat sink and fan) is not properly installed and the system turned on, permanent damage to the CPU, 3307675 and other electronic components attached to the system may be

incurred. Running a CPU without a cooling kit may also result in injury to the user.

The CPU, CPU cooling kit and DIMM are the most critical components of the 3307675. If one of these components is not installed the 3307675 cannot run.

5.4.1 LGA775 CPU Installation



NOTE:

Enabling Hyper-Threading Technology on your system requires meeting all of the platform requirements listed below:

- CPU: An Intel® Pentium 4 Processor with HT Technology must be installed
- Chipset: An Intel® Chipset that supports HT Technology (that has been met by the 3307675)
- OS: An operating system that has optimizations for HT Technology



WARNING:

CPUs are expensive and sensitive components. When installing the CPU please be careful not to damage it in anyway. Make sure the CPU is installed properly and ensure the correct cooling kit is properly installed.

The LGA775 socket is shown in Figure 5-1.

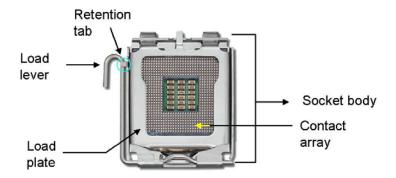


Figure 5-1: Intel LGA775 Socket

To install a socket LGA775 CPU onto the 3307675, follow the steps below:



WARNING:

When handling the CPU, only hold it on the sides. DO NOT touch the pins at the bottom of the CPU.

Step 1: Remove the protective cover. Remove the black protective cover by prying it off the load plate. To remove the protective cover, locate the "REMOVE" sign and use your fingernail to pry the protective cover off. See Figure 5-2.

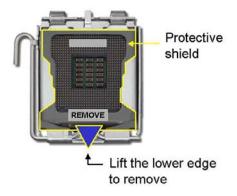


Figure 5-2: Remove the CPU Socket Protective Shield

Step 2: Open the socket. Disengage the load lever by pressing the lever down and slightly outward to clear the retention tab. Rotate the load lever to a fully open

position. Then rotate the load plate towards the opposite direction. See **Figure** 5-3.

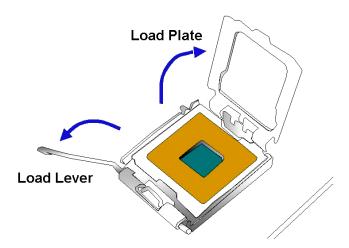


Figure 5-3: Open the CPU Socket Load Plate

- Step 3: Inspect the CPU socket Make sure there are no bent pins and make sure the socket contacts are free of foreign material. If any debris is found, remove it with compressed air.
- **Step 4: Orientate the CPU properly**. Make sure the IHS (Integrated Heat Sink) side is facing upward.
- Step 5: Correctly position the CPU. Match the Pin 1 mark with the cut edge on the CPU socket.
- Step 6: Align the CPU pins. Locate pin 1 and the two orientation notches on the CPU.

 Carefully match the two orientation notches on the CPU with the socket alignment keys.
- Step 7: Insert the CPU. Gently insert the CPU into the socket. If the CPU pins are properly aligned, the CPU should slide into the CPU socket smoothly. See Figure 5-4.

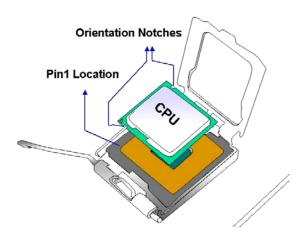


Figure 5-4: Insert the Socket LGA775 CPU

Step 8: Close the CPU socket. Close the load plate and engage the load lever by pushing it back to its original position. Secure the load lever under the retention tab on the side of CPU socket.

Step 9: Connect the CPU 12V cable to the 12After the cooling kit is installed connect the CPU cable to the CPU 12V power connectorStep 0:

5.4.2 LGA775 Cooling Kit Installation



WARNING:

It is strongly recommended that you DO NOT use the original heat sink and cooler provided by Intel on the 3307675.

GLOBAL AMERICAN, INC.'s cooling kits include a support bracket that is combined with the heat sink mounted on the CPU to counterweigh and balance the load on both sides of the PCB.



Figure 5-5: GLOBAL AMERICAN, INC. 2107695 Cooling Kit

Two optional, separately purchased LGA775 GLOBAL AMERICAN, INC. CPU cooling kits are available. The GLOBAL AMERICAN, INC. 2107695 is shown in **Figure 5-5** and can be purchased separately. The cooling kit comprises a CPU heat sink and a cooling fan.



WARNING:

Do not wipe off (accidentally or otherwise) the pre-sprayed layer of thermal paste on the bottom of the [Fan model#] heat sink. The thermal paste between the CPU and the heat sink is important for optimum heat dissipation.

To install the cooling kit follow the instructions below.

- Step 1: Place the cooling kit onto the socket LGA775 CPU. Make sure the CPU cable can be properly routed when the cooling kit is installed.
- Step 2: Properly align the cooling kit. Make sure the four spring screw fasteners can pass through the pre-drilled holes on the PCB.
- Step 3: Mount the cooling kit. Gently place the cooling kit on top of the CPU. Make sure the four threaded screws on the corners of the cooling kit properly pass through the predrilled holes on the bottom of the PCB.
- Step 4: Secure the cooling kit. From the solder side of the PCB, align the support

bracket to the screw threads on heat sink that were inserted through the PCB holes. (See **Figure 5-6**)

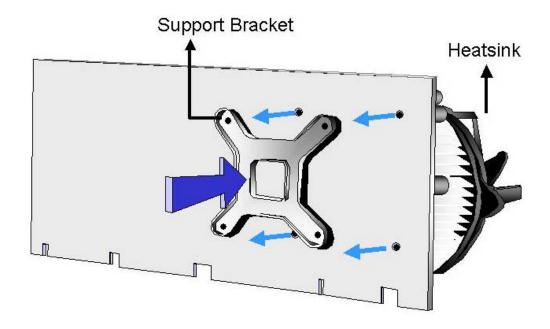


Figure 5-6: Securing the Heat sink to the PCB Board

- **Step 5: Tighten the screws**. Use a screwdriver to tighten the four screws. Tighten each nut a few turns at a time and do not over-tighten the screws.
- Step 6: Connect the fan cable. Connect the cooling kit fan cable to the fan connector on the 3307675. Carefully route the cable and avoid heat generating chips and fan blades. Step 0:

5.4.3 DIMM Installation



WARNING:

Using incorrectly specified DIMM may cause permanently damage the 3307675. Please make sure the purchased DIMM complies with the memory specifications of the 3307675. DIMM specifications compliant

with the 3307675 are listed in Chapter 2.

To install a DIMM into a DIMM socket, please follow the steps below and refer to **Figure** 5-7.

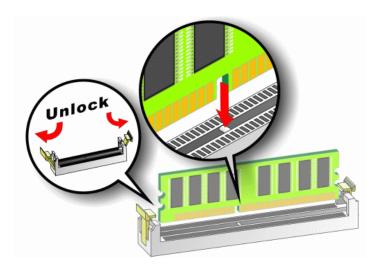


Figure 5-7: Installing a DIMM

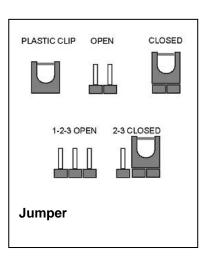
- Step 1: Open the DIMM socket handles. The DIMM socket has two handles that secure the DIMM into the socket. Before the DIMM can be inserted into the socket, the handles must be opened. See Figure 5-7.
- Step 2: Align the DIMM with the socket. The DIMM must be oriented in such a way that the notch in the middle of the DIMM must be aligned with the plastic bridge in the socket. See Figure 5-7.
- Step 3: Insert the DIMM. Once properly aligned, the DIMM can be inserted into the socket. As the DIMM is inserted, the white handles on the side of the socket will close automatically and secure the DIMM to the socket. See Figure 5-7.
- **Step 4:** Removing a DIMM. To remove a DIMM, push both handles outward. The memory module is ejected by a mechanism in the socket. **Step 0:**

5.5 Jumper Settings



NOTE:

A jumper is a metal bridge that is used to close an electrical circuit. It consists of two metal pins and a small metal clip (often protected by a plastic cover) that slides over the pins to connect them. To CLOSE/SHORT a jumper means connecting the pins of the jumper with the plastic clip and to OPEN a jumper means removing the plastic clip from a jumper.



Before the 3307675 is installed in the system, the jumpers must be set in accordance with the desired configuration. The jumpers on the 3307675 are listed in **Table 5-1**.

Description	Label	Туре
Clear CMOS	J_CMOS1	3-pin header

Table 5-1: Jumpers

5.5.1 Clear CMOS Jumper

Jumper Label: J_CMOS1

Jumper Type: 3-pin header

Jumper Settings: See Table 5-2

Jumper Location: See Figure 5-8

If the 3307675 fails to boot due to improper BIOS settings, the clear CMOS jumper clears the CMOS data and resets the system BIOS information. To do this, use the jumper cap to close pins 2 and 3 for a few seconds then reinstall the jumper clip back to pins 1 and 2.

If the "CMOS Settings Wrong" message is displayed during the boot up process, the fault may be corrected by pressing the F1 to enter the CMOS Setup menu. Do one of the following:

- Enter the correct CMOS setting
- Load Optimal Defaults
- Load Failsafe Defaults.

After having done one of the above, save the changes and exit the CMOS Setup menu. The clear CMOS jumper settings are shown in **Table 5-2**.

Jumper Select	Description	
Short 1 - 2	Keep CMOS Setup	Default
Short 2 - 3	Clear CMOS Setup	

Table 5-2: Clear CMOS Jumper Settings

The location of the clear CMOS jumper is shown in Figure 5-8 below.

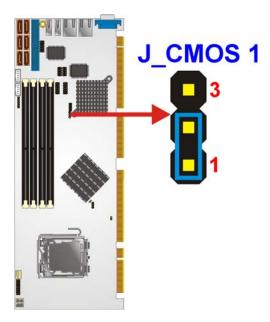


Figure 5-8: Clear CMOS Jumper

5.6 Chassis Installation

5.6.1 Airflow



Airflow is critical to the cooling of the CPU and other onboard components. The chassis in which the 3307675 must have air vents to allow cool air to move into the system and hot air to move out.

The 3307675 must be installed in a chassis with ventilation holes on the sides allowing airflow to travel through the heat sink surface. In a system with an individual power supply unit, the cooling fan of a power supply can also help generate airflow through the board surface.



GLOBAL AMERICAN, INC. has a wide range of backplanes available. Please contact your 3307675 vendor, reseller or a Global American sales representative at salesinfo@globalamericaninc.com or visit the **GLOBAL** INC. AMERICAN, website (http://www.globalamericaninc.com) to find out more about the available chassis.

5.6.2 Backplane Installation

Before the 3307675 can be installed into the chassis, a backplane must first be installed. Please refer to the installation instructions that came with the backplane and the chassis to see how to install the backplane into the chassis.



NOTE:

GLOBAL AMERICAN, INC. has a wide range of backplanes available. Please contact your 3307675 vendor, reseller or a Global American sales representative at salesinfo@globalamericaninc.com or visit the GLOBAL AMERICAN, INC. website (http://www.globalamericaninc.com) to find out more about the available chassis.

5.6.3 CPU Card Installation

To install the 3307675 CPU card onto the backplane, carefully align the CPU card interface connectors with the corresponding socket on the backplane. To do this, please refer to the reference material that came with the backplane. Next, secure the CPU card to the chassis. To do this, please refer to the reference material that came with the chassis.

5.7 Internal Peripheral Device Connections

5.7.1 Peripheral Device Cables

The cables listed in **Table 5-3** are shipped with the 3307675.

Quantity	Туре
1	ATA 66/100 flat cable
1	Dual RS-232 cable
1	5-pin wafer-to-PS/2 cable
6	SATA drive cables
3	SATA drive power cables
1	USB cable

Table 5-3: GLOBAL AMERICAN, INC. Provided Cables

Separately purchased optional GLOBAL AMERICAN, INC. items that can be installed are listed below:

- Audio kit
- 5-pin wafer-to-PS/2 cable
- 4-port USB cable
- PCle x16 VGA output SDVO card
- PCle x16 DVI output SDVO card

For more details about the items listed above, please refer to **Chapter 3**. Installation of the accessories listed above are described in detail below.

5.7.2 ATA Flat Cable Connection

The ATA 66/100 flat cable connects to the 3307675 to one or two IDE devices. To connect an IDE HDD to the 3307675 please follow the instructions below.

Step 1: Locate the IDE connector. The location/s of the IDE device connector/s is/are

shown in Chapter 3.

Step 2: Insert the connector. Connect the IDE cable connector to the onboard connector. See Figure 5-9. A key on the front of the cable connector ensures it can only be inserted in one direction.

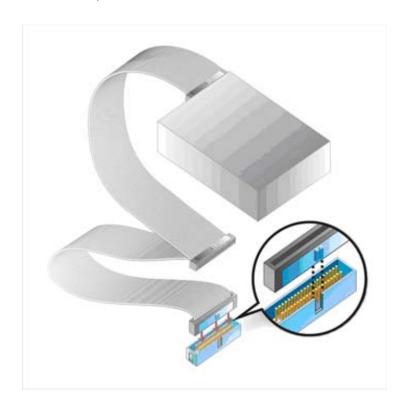


Figure 5-9: IDE Cable Connection

Step 3: Connect the cable to an IDE device. Connect the two connectors on the other side of the cable to one or two IDE devices. Make sure that pin 1 on the cable corresponds to pin 1 on the connectorStep 0:

5.7.3 Audio Kit Installation

An optional audio kit that is separately ordered connects to the 9-pin audio connector on the 3307675. The audio kit consists of five audio jacks. One audio jack, Mic In, connects to a microphone. The remaining four audio jacks, Front-In, Front-Out, Rear-Out and subwoofer connect to four speakers including a subwoofer. To install the audio kit, please refer to the steps below:

- Step 1: Locate the audio connector. The location of the 10-pin audio connector is shown in Chapter 3.
- Step 2: Align pin 1. Align pin 1 on the onboard connector with pin 1 on the audio kit connector. Pin 1 on the audio kit connector is indicated with a white dot. See Figure 5-10.

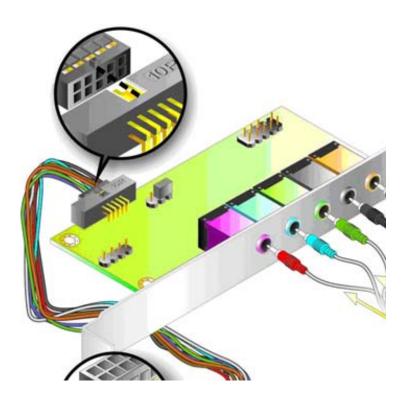


Figure 5-10: Audio Kit Connection

Step 3: Connect the audio devices. Connect the speakers and the subwoofer to the appropriate audio jack shown in Figure 5-10.Step 0:

5.7.4 Keyboard/Mouse Installation

To install a keyboard or mouse, a PS/2 cable must be attached to the keyboard or mouse connector. The 3307675 has an independent 5-pin keyboard connector and independent 5-pin mouse connector on board. To connect either of these connectors to a keyboard or mouse, please do the following.

- Step 1: Locate the keyboard or mouse connector. The locations of the 5-pin keyboard connector and the 5-pin mouse connector are shown in **Chapter 3**.
- Step 2: Align pin 1. Align pin 1 on the onboard connector with pin 1 on the cable connector. See Figure 5-10.



Figure 5-11: Keyboard/Mouse Connection

- Step 3: Secure the PS/2 connector to the chassis. Use two retention screws to secure the PS/2 on the end of the cable to the chassis.
- Step 4: Connect the keyboard or mouse. If the cable has been connected to the 3307675 keyboard connector, connect a PS/2 keyboard to the PS/2 connector on the cable. If the cable has been connected to the 3307675 mouse connector, connect a PS/2 mouse to the PS/2 connector on the keyboard. Figure 5-10.
 Step 0:

5.7.5 Dual RS-232 Cable Connection

The dual RS-232 cable consists of two connectors attached to two independent cables. Each cable is then attached to a D-sub 9 male connector that is mounted onto a bracket. To install the dual RS-232 cable, please follow the steps below.

- Step 1: Locate the connectors. The locations of the RS-232 connectors are shown in Chapter 3.
- Step 2: Insert the cable connectors. Insert one connector into each serial port box headers. See Figure 5-12. A key on the front of the cable connectors ensures the connector can only be installed in one direction.

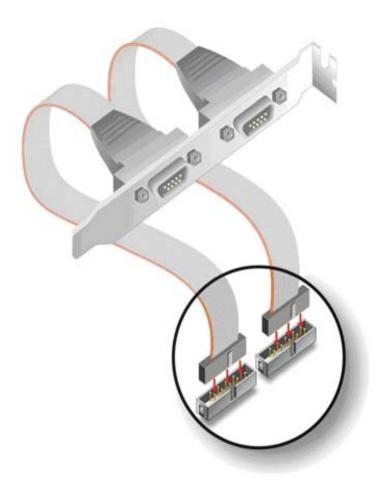


Figure 5-12: Dual RS-232 Cable Installation

Step 3: Secure the bracket. The dual RS-232 connector has two D-sub 9 male connectors secured on a bracket. To secure the bracket to the chassis please

refer to the reference material that came with the chassisStep 0:

5.7.6 SATA Drive Connection

The 3307675 is shipped with two SATA drive cables and one SATA drive power cable. To connect the SATA drives to the connectors, please follow the steps below.

- **Step 1:** Locate the connectors. The locations of the SATA drive connectors are shown in **Chapter 3**.
- Step 2: Insert the cable connector. Press the clip on the connector at the end of the SATA cable and insert the cable connector into the onboard SATA drive connector. See Figure 5-13.

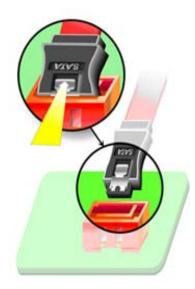


Figure 5-13: SATA Drive Cable Connection

- Step 3: Connect the cable to the SATA disk. Connect the connector on the other end of the cable to the connector at the back of the SATA drive. See Figure 5-14.
- Step 4: Connect the SATA power cable. Connect the SATA power connector to the back of the SATA drive. See Figure 5-14. Step 0:



Figure 5-14: SATA Power Drive Connection

5.7.7 USB Cable (Dual Port)

The 3307675 is shipped with a dual port USB 2.0 cable. To connect the USB cable connector, please follow the steps below.

Step 1: Locate the connectors. The locations of the USB connectors are shown in Chapter 3.



WARNING:

If the USB pins are not properly aligned, the USB device can burn out.

- Step 2: Align the connectors. The cable has two connectors. Correctly align pin 1 on each cable connector with pin 1 on the 3307675 USB connector.
- Step 3: Insert the cable connectors. Once the cable connectors are properly aligned with the USB connectors on the 3307675, connect the cable connectors to the onboard connectors. See Figure 5-15.

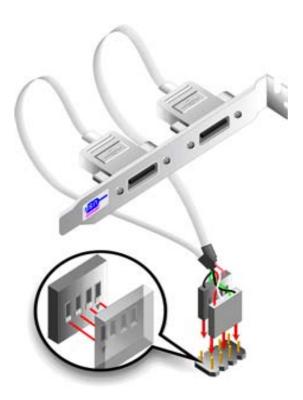


Figure 5-15: Dual USB Cable Connection

Step 4: Attach the bracket to the chassis. The USB 2.0 connectors are attached to a bracket. To secure the bracket to the chassis please refer to the installation instructions that came with the chassis.Step 0:

5.7.8 USB Cable (Four Port)

Four port USB 2.0 cables can be separately purchased from GLOBAL AMERICAN, INC.. To install a four port USB cable onto the 3307675, please follow the steps below.

Step 1: Locate the connectors. The locations of the USB connectors are shown in Chapter 4.



If the USB pins are not properly aligned, the USB device can burn out.

- Step 2: Align the connectors. Each cable has two connectors. Correctly align pin 1 on each cable connector with pin 1 on the 3307675 USB connectors.
- Step 3: Insert the cable connectors.. Once the cable connectors are properly aligned with the USB connectors on the 3307675, connect the cable connectors to the onboard connectors. See Figure 5-15.

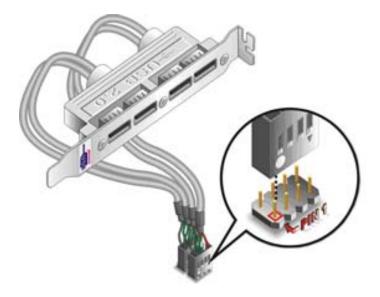


Figure 5-16: Four Port USB Cable Connection

Step 4: Attach the bracket to the chassis. The USB 2.0 connectors are attached to a bracket. To secure the bracket to the chassis please refer to the installation instructions that came with the chassis. Step 0:

5.8 External Peripheral Interface Connection

The following external peripheral devices can be connected to the external peripheral interface connectors.

VGA monitors

- RJ-45 Ethernet cable connectors
- USB devices

To install these devices, connect the corresponding cable connector from the actual device to the corresponding 3307675 external peripheral interface connector making sure the pins are properly aligned.

5.8.1 LAN Connection (Single Connector)

There are two external RJ-45 LAN connectors. The RJ-45 connectors enable connection to an external network. To connect a LAN cable with an RJ-45 connector, please follow the instructions below.

- **Step 1:** Locate the RJ-45 connectors. The locations of the USB connectors are shown in Chapter 4.
- **Step 2:** Align the connectors. Align the RJ-45 connector on the LAN cable with one of the RJ-45 connectors on the 3307675. See **Figure 5-17**.

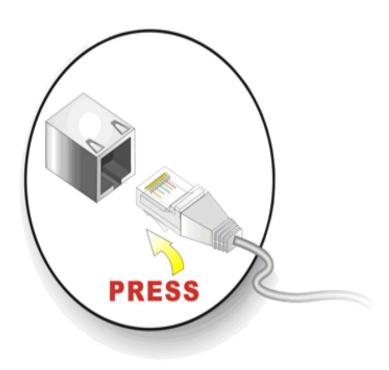


Figure 5-17: LAN Connection

Step 3: Insert the LAN cable RJ-45 connector. Once aligned, gently insert the LAN cable RJ-45 connector into the onboard RJ-45 connector. Step 0:

5.8.2 USB Device Connection (Single Connector)

There are two external USB 2.0 connectors. Both connectors are perpendicular to the 3307675. To connect a USB 2.0 or USB 1.1 device, please follow the instructions below.

- **Step 1:** Located the USB connectors. The locations of the USB connectors are shown in Chapter 4.
- Step 2: Align the connectors. Align the USB device connector with one of the connectors on the 3307675. See Figure 5-17.

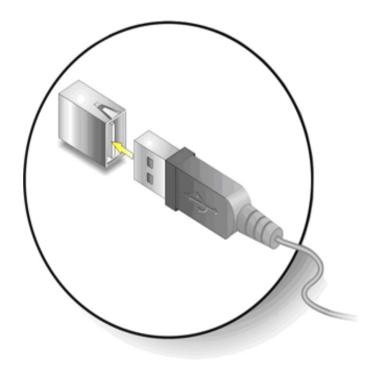


Figure 5-18: USB Device Connection

Step 3: Insert the device connector. Once aligned, gently insert the USB device

connector into the onboard connector. Step 0:

5.8.3 VGA Monitor Connection

The 3307675 has a single female DB-15 connector on the external peripheral interface panel. The DB-15 connector is connected to a CRT or VGA monitor. To connect a monitor to the 3307675, please follow the instructions below.

- Step 1: Locate the female DB-15 connector. The location of the female DB-15 connector is shown in Chapter 3.
- **Step 2:** Align the VGA connector. Align the male DB-15 connector on the VGA screen cable with the female DB-15 connector on the external peripheral interface.
- Step 3: Insert the VGA connector. Once the connectors are properly aligned with the insert the male connector from the VGA screen into the female connector on the 3307675. See Figure 5-19.

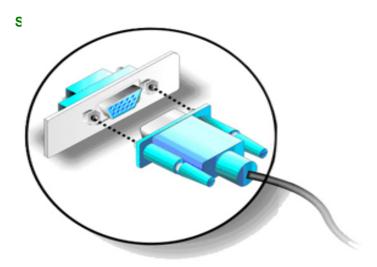
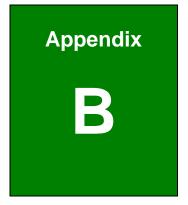


Figure 5-19: VGA Connector

Secure the connector. Secure the DB-15 VGA connector from the VGA monitor to the external interface by tightening the two retention screws on either side of

the connector. Step 0:



DIO Interface

A.1 DIO Interface Introduction

The DIO connector on the 3307675 is interfaced to GIO ports on the iTE Super I/O chipset. The DIO has both 4-bit digital inputs and 4-bit digital outputs. The digital inputs and digital outputs are generally control signals that control the on/off circuit of external devices or TTL devices. Data can be read or written to the selected address to enable the DIO functions.



For further information, please refer to the datasheet for the iTE Super I/O chipset.

A.2 DIO Connector Pinouts

The following table describes how the DIO connector pins are connected to the Super I/O GPIO port 1.

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	GND	2	vcc
3	Output 3	4	Output 2
5	Output 1	6	Output 0
7	Input 3	8	Input 2
9	Input 1	10	Input 0

A.3 Assembly Language Samples

A.3.1 Enable the DIO Input Function

The BIOS interrupt call INT 15H controls the digital I/O. An assembly program to enable digital I/O input functions is listed below.

MOV	AX, 6F08H	Sets the digital port as input
INT	15H	Initiates the INT 15H BIOS call

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A.3.2 Enable the DIO Output Function

The BIOS interrupt call INT 15H controls the digital I/O. An assembly program to enable digital I/O output functions is listed below.

MOV	AX, 6F09H	Sets the digital port as output
MOV	BL, 09H	
INT	15H	Initiates the INT 15H BIOS call

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Appendix

Watchdog Timer



The following discussion applies to DOS environment. GLOBAL AMERICAN, INC. support is contacted or the GLOBAL AMERICAN, INC. website visited for specific drivers for more sophisticated operating systems, e.g., Windows and Linux.

The Watchdog Timer is provided to ensure that standalone systems can always recover from catastrophic conditions that cause the CPU to crash. This condition may have occurred by external EMI or a software bug. When the CPU stops working correctly, Watchdog Timer either performs a hardware reset (cold boot) or a Non-Maskable Interrupt (NMI) to bring the system back to a known state.

A BIOS function call (INT 15H) is used to control the Watchdog Timer:

INT 15H:

AH – 6FH Sub-function:		
AL – 2:	Sets the Watchdog Timer's period.	
BL:	Time-out value (Its unit-second is dependent on the item "Watchdog	
	Timer unit select" in CMOS setup).	

Table B-1: AH-6FH Sub-function

Call sub-function 2 to set the time-out period of Watchdog Timer first. If the time-out value is not zero, the Watchdog Timer starts counting down. While the timer value reaches zero, the system resets. To ensure that this reset condition does not occur, calling sub-function 2 must periodically refresh the Watchdog Timer. However, the Watchdog timer is disabled if the time-out value is set to zero.

A tolerance of at least 10% must be maintained to avoid unknown routines within the operating system (DOS), such as disk I/O that can be very time-consuming.

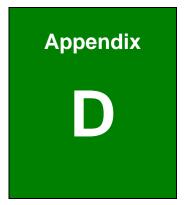


When exiting a program it is necessary to disable the Watchdog Timer, otherwise the system resets.

Example program:

```
; INITIAL TIMER PERIOD COUNTER
W_LOOP:
             AX, 6F02H
      MOV
                           ; setting the time-out value
      MOV
             BL, 30
                           ; time-out value is 48 seconds
              15H
      INT
; ADD THE APPLICATION PROGRAM HERE
      CMP
              EXIT_AP, 1
                               ; is the application over?
      JNE
              W_LOOP
                           ; No, restart the application
      MOV
             AX, 6F02H
                           ; disable Watchdog Timer
      MOV
             BL, O
      INT
             15H
; EXIT;
```

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Address Mapping

C.1 Address Map

I/O address Range	Description
000-01F	DMA Controller
020-021	Interrupt Controller
040-043	System time
060-06F	Keyboard Controller
070-07F	System CMOS/Real time Clock
080-09F	DMA Controller
0A0-0A1	Interrupt Controller
OCO-ODF	DMA Controller
OFO-OFF	Numeric data processor
1F0-1F7	Primary IDE Channel
2F8-2FF	Serial Port 2 (COM2)
378-37F	Parallel Printer Port 1 (LPT1)
3B0-3BB	Intel Graphics Controller
3C0-3DF	Intel Graphics Controller
3F6-3F6	Primary IDE Channel
3F7-3F7	Standard floppy disk controller
3F8-3FF	Serial Port 1 (COM1)

Table C-1: IO Address Map

C.2 1st MB Memory Address Map

Memory address	Description
00000-9FFFF	System memory
A0000-BFFFF	VGA buffer
F0000-FFFFF	System BIOS
100000-	Extend BIOS

Table C-2: 1st MB Memory Address Map

C.3 IRQ Mapping Table

IRQ0	System Timer	IRQ8	RTC clock
IRQ1	Keyboard	IRQ9	ACPI
IRQ2	Available	IRQ10	LAN
IRQ3	COM2	IRQ11	LAN/USB2.0/SATA
IRQ4	COM1	IRQ12	PS/2 mouse
IRQ5	SMBus Controller	IRQ13	FPU
IRQ6	FDC	IRQ14	Primary IDE
IRQ7	Available	IRQ15	Secondary IDE

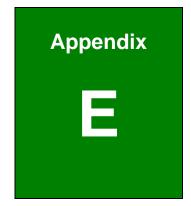
Table C-3: IRQ Mapping Table

C.4 DMA Channel Assignments

Channel	Function	
0	Available	
1	Available	
2	Floppy disk (8-bit transfer)	
3	Available	
4	Cascade for DMA controller 1	
5	Available	
6	Available	
7	Available	

Table C-4: IRQ Mapping Table

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Intel® Matrix Storage Manager

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D.1 Introduction

The Intel® ICH7R chipset can provide data protection for serial ATA (SATA) disks via the Intel® Matrix Storage Manager using one of three fault-tolerant RAID levels: RAID 1, 5 or 10. When using two hard drives, matrix RAID allows RAID 0 and RAID 1 functions to be combined, where critical files can be stored on RAID 1, and RAID 0 can be used for non-critical items such as software. RAID 5 and RAID 0 can be combined to provide higher performance, capacity, and fault tolerance.



CAUTION!

A configured RAID volume (which may consist of multiple hard drives) appears to an operating system as a contingent storage space. The operating system will not be able to distinguish the physical disk drives contained in a RAID configuration.

D.1.1 Precautions

One key benefit a RAID configuration brings is that a single hard drive can fail within a RAID array without damaging data. With RAID1 array, a failed drive can be replaced and the RAID configuration restored.



WARNING!

Irrecoverable data loss occurs if a working drive is removed when trying to remove a failed drive. It is strongly recommended to mark the physical connections of all SATA disk drives. Drive locations can be identified by attaching stickers to the drive bays. If a drive member of a RAID array should fail, the failed drive can then be correctly identified.



CAUTION!

Do not accidentally disconnect the SATA drive cables. Carefully route the cables within the chassis to avoid system down time.

D.2 Features and Benefits

- Supports RAID levels 0, 1, 5 and 10
- Supports connectivity to two or more disk drives
- Supported Operating Systems include: Windows XP, Windows Server 2003 and Windows Vista

D.3 Accessing the Intel® Matrix Storage Manager

To access the Intel® Matrix Storage Manager, please follow the steps below.

Step 1: Connect SATA drives to the system. Connect two or more SATA drives to the system. Make sure the drives have the same capacity, are the same type and have the same speed.



NOTE:

Make sure the SATA drives are EXACTLY the same when they are configured in a RAID configuration. If they are not the same size, disk drive capacity is sacrificed and overall performance affected.

Step 2: Enable SATA drives in BIOS. Start the computer and access the BIOS setup program. Enable SATA support for all IDE devices. Refer to the applicable BIOS configuration section in this user manual.

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- Step 3: Save and Exit BIOS. After the SATA support option is enabled, save and exit the BIOS.
- Step 4: Reboot the system. Reboot the system after saving and exiting the BIOS.
- Step 5: Press Ctrl+I. During the system boot process, press Ctrl+I when prompted to enter the RAID configuration software.
- Step 6: Configure the RAID settings. Use the Intel® Matrix Storage Manager to configure the RAID array. Brief descriptions of configuration options are given below.
- Step 7: Install the OS. After the RAID array has been configured, install the OS. To do this, please refer to the documentation that came with the OS. Step 0:

D.4 RAID Configuration

D.4.1 Creating a RAID Volume



WARNING!

All data previously stored on the member drives of a RAID configuration are destroyed during the RAID initialization process. If "used" drives are used to create a RAID array, make sure the data has been moved or backed up before creating a RAID array out of the disk drives.

Step 1: Select "Create RAID Volume." Use the arrow keys to highlight Create RAID Volume and press ENTER. See Figure D-1.



Figure D-1: Matrix Storage Manager Main Menu

Step 2: Name the RAID volume. Enter a name for the RAID volume, or press ENTER to accept the default volume name. Upper and lower case alphabetic, numeric, space, and underscore characters are all applicable for naming an array. See Figure D-2.



Figure D-2: Create RAID Volume Name

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Step 3: Choose the RAID level. Select a RAID level from the list. RAID levels include RAID 0, 1, 5 and 10. See Figure D-3.



RAID 0 and RAID1 levels require a minimum of two hard drives.

RAID 10 level requires a minimum of four hard drives.

RAID5 level requires a minimum of three hard drives.

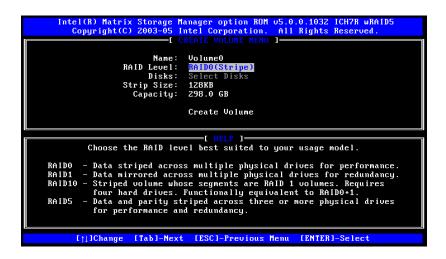


Figure D-3: Choose the Raid Level

Step 4: Select the Stripe Size. Select a stripe size from the list. See Figure D-4.

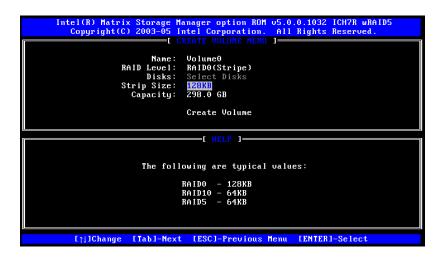


Figure D-4: Select the Stripe Size

Step 5: Enter the Volume Capacity. Enter the volume capacity, or press **ENTER** to accept the default capacity. See Figure D-5.

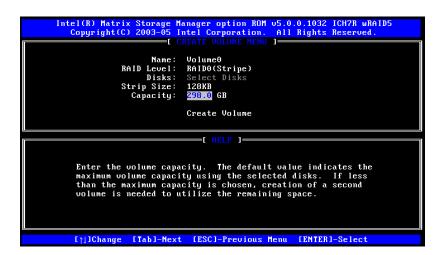


Figure D-5: Enter the Volume Capacity

Step 6: Create the RAID Volume. Press ENTER to create the RAID volume as specified. See Figure D-6.

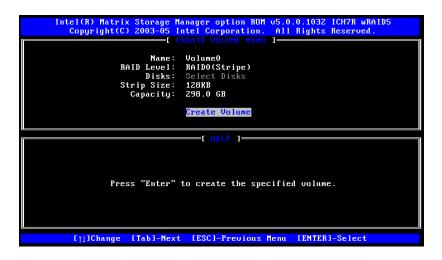


Figure D-6: Create the RAID Volume

Step 7: Create RAID Volume Verification. After reading the warning, press Y to create the RAID volume as specified, or N to return to the Create RAID Volume menu.
See Figure D-7. Step 0:



Figure D-7: Create RAID Volume Verification

D.4.2 Deleting a RAID Volume



WARNING!

All data stored on the member drives of a RAID volume are destroyed during the RAID deletion process. Make sure any data to be saved has been moved or backed up before deleting a RAID volume.

Step 1: Select "Delete RAID Volume." Use the arrow keys to highlight Delete RAID Volume and press ENTER. See Figure D-8.



Figure D-8: Delete RAID Volume Menu

Step 2: Select RAID Volume to be Deleted. Use the arrow keys to highlight the RAID volume to be deleted and press ENTER. See Figure D-9.

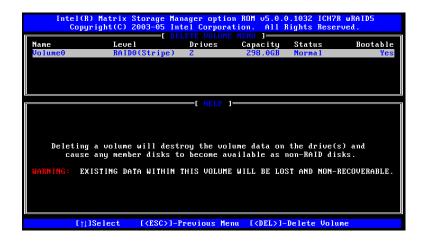


Figure D-9: Select RAID Volume to be Deleted

Step 3: Delete Volume Verification. After reading the warning, press Y to delete the specified RAID volume, or N to return to the Delete Volume menu.

See Figure D-10.

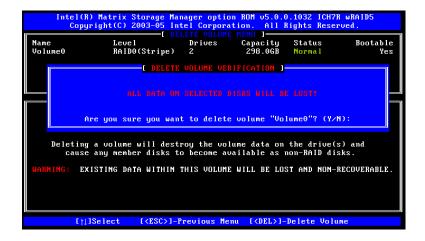


Figure D-10: Delete Volume Verification

Step 4: Non-RAID Disks. After deleting the RAID volume, the disks belonging to the volume will be shown as non-RAID disks. See Figure D-11. **Step 0:**



Figure D-11: Non-RAID Disks

D.4.3 Resetting a Disk to Non-RAID



WARNING!

All data stored on the disk drive of a RAID volume is destroyed when resetting it to non-RAID. Make sure any data to be saved has been moved or backed up before resetting a disk to non-RAID.

Step 1: Select "Reset Disk to Non-RAID." Use the arrow keys to highlight Reset Disk to Non-RAID and press ENTER. See Figure D-12.



Figure D-12: Reset Disk to Non-RAID Menu

Step 2: Select Disks to Reset. Use the arrow keys to scroll through the disk drives and press SPACE to select which drives are to be reset as non-RAID. After all the disks to be reset have been chosen, press ENTER. See Figure D-13.



Figure D-13: Select Disk to Reset

Step 3: Reset Disk Verification. After reading the warning, press Y to reset the selected disks as non-RAID, or N to return to the Reset RAID Data menu.

See Figure D-14.

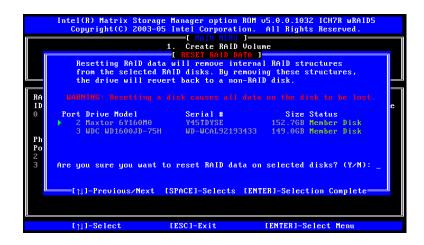


Figure D-14: Reset Disk Verification

Step 4: Disk Drive and RAID Volume Status. After the disk drives have been reset, the

Matrix Storage Manager Main menu is shown indicating the status of the RAID

volumes and disk drives. See Figure D-15. Step 0:



Figure D-15: Disk Drive and RAID Volume Status

D.4.4 Exiting the Matrix Storage Manager

Step 1: Select "Exit." Use the arrow keys to highlight Exit and press ENTER.

See Figure D-16.

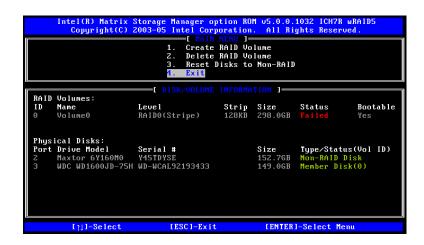


Figure D-16: Exit Menu

Step 2: Exit Verification. Press Y to exit the Matrix Storage Manager, or N to return to the Main menu. See Figure D-17. Step 0:



Figure D-17: Exit Verification

Any advice or comments about our products and service, or anything we can help you with please don't hesitate to contact with us. We will do our best to support your products, projects and business.



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